Assembléon

LEADERS IN ELECTRONIC MANUFACTURING TECHNOLOGY

May 2003

GemLine
TOPAZ-X(i) II series
SPECIFICATIONS

PA 1314/01	Topaz-X II (FNC)
PA 1314/02	Topaz-X II (SF)
PA 1314/10	Topaz-Xi II (FNC)
PA 1314/11	Topaz-Xi II (SF)

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Contents

1.0 Introducing the GEM Topaz-X(i) II series

The new Topaz-X(i) II series, part of the Modular High Speed Production Machines, belongs to the top-of-the-line of Assembléon's SMD pick & place machines.

With the Topaz-Xi II a feeder commonality between all Assembléon machines has been introduced which increases the Topaz-X II flexibility.

The Topaz-X(i) II is a High Speed flexible machine that can handle a wide range of components at speeds up to 19,500 SMDs per hour. The machine is built around a very rigid, vibration-free frame for improved accuracy and long-term stability and is perfectly suitable for round-the-clock production.

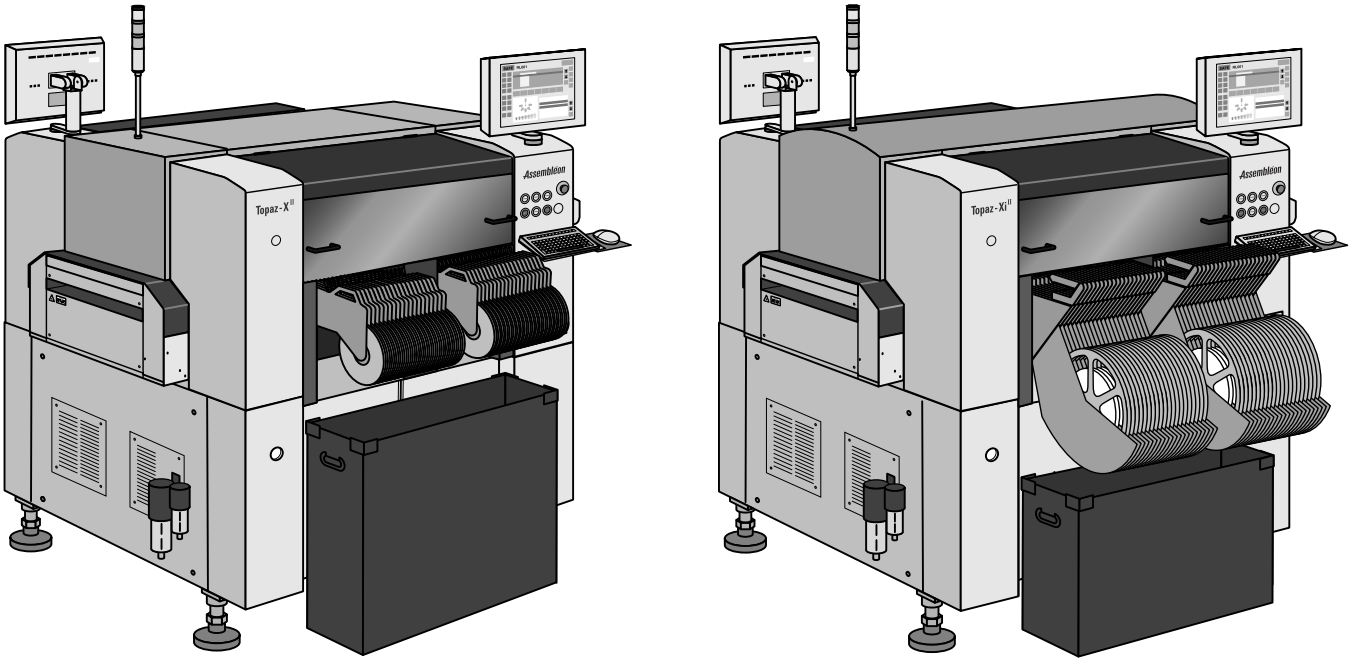


Figure 1 *Front view GEM Topaz-X(i) II.*

The Topaz-X(i) II features a high precision single placement beam carrying 4 Flying Nozzle Change heads (each equipped with 3 nozzles) and 4 standard heads with exchangeable nozzles or 8 Super Fine heads with exchangeable nozzles. The placement beam moves in X/Y and Z direction, while the board and component feeders are stationary. A flexible board transport system enables the Topaz-X(i) II to handle virtually any type of PCB, with or without tooling pins. Board conveyor width is automatically adjustable, allowing board dimensions up to 460 x 440mm (18.1" x 17.3") to be handled.

The newly designed vision system with Line Array camera allows fast and accurate 'on-the-fly' alignment of a wide range of components from 0201 up to 45 mm square PLCC, including 45 mm square QFPs with lead pitches down to 0.5 mm (20 mil). Dark background BGAs, µBGAs and CSPs with ball pitches down to 0.5 mm (20 mil) and ball diameters down to 0.3 mm (12 mil) can be recognized with the use of new developed illumination unit which allows measurement of ball positions and dimensions.

An optional single area CCD camera extends the component range to 32mm square ICs with lead pitches down to 0.4mm (16 mil). The vision system detects missing, bent or irregular spaced leads or BGA balls; faulty components are rejected.

A separate camera system monitors fiducial marks at the board, circuit and component level, using a combination of white-light and IR LEDs with multi-angle diffusers to provide optimal illumination.

Just five nozzle shapes are required to cover the specified SMD range. High output levels are therefore achieved, as the need for nozzle exchanges is minimal. An optional 18 position nozzle exchange station enables additional special nozzles to be accommodated.

Up to 90 tape feeders can be loaded on the Topaz-X II and 80 on the Topaz-Xi II. The machine supports tape, stick, bulk and tray feeders.

The tape feeder design for the Topaz-X II allows simultaneous picking from any mix of tape feeders ranging from 8 to 56 mm.

A Windows NT based controller, running an user-friendly Graphical User Interface, allows the Topaz-X(i) II to be used stand-alone or in-line. The controller includes a Management Information System (MIS) that continuously gathers production data for management feedback. The unique bad mark sensing capabilities allow a multi-circuit panel to be run as one large board, thus maximizing placement speed while still using bad mark information. A laser-based verification system, which guarantees correct feeder latching, is standard.

The Topaz-X II is fully compatible with the Emerald-X II which use the same feeders, feederbars, software and controller. Off-line feeder changeover can be achieved by using a 20 position Feederbar Exchange System (FES). An entire feederbar can be conveniently loaded off-line, minimizing change-over time.

A basic program optimization function is also included in the machine as standard which can be used during production. For more advanced machine optimization and/or line balancing, the new Production Preparation System allows you to create and optimize SMD machine programs on a PC instead of using the SMD machine.

2.0 General Specifications

	Topaz-X II (FNC)	Topaz-X II (SF)	
			REMARKS
Tact time:	0.18 sec/chip with line array camera		Simultaneous pick with 8 heads
	0.36 sec/SO with line array camera		Simultaneous pick with 4 heads
	1.4 sec/QFP with line array camera		Sequential pick with 4 heads
	1.7 sec/QFP with line array camera		With 1 head
	3.7 sec/QFP with area CCD camera		In fine mode with 1 head
Optimal placement rate:	19,500 cph		Simultaneous pick with 8 heads (at best conditions)
IPC 9850	15,400 cph		C0603; all heads, all angles
Nominal placement rate:	12,000 - 14,000 cph		Real mounting time
Applicable components:	0201 - SOP, SOJ, PLCC 32mm ⍁ (1.26") 6mm - QFP 32mm ⍁ (1.26" with pin pitch down to 0.4mm(16 mil) QFP 32mm - QFP 45mm ⍁ (1.77") with pin pitch down to 0.5mm (20 mil) Dark background BGA, µBGA, CSP with regular pitches; 6mm - 32mm: Min. ball pitch down to 0.5mm (20mil); Min. ball diameter down to 0.3mm (12mil)		Line array camera system (32mm) Line array camera system (45mm) optional
	6mm - QFP 32mm ⍁ (1.26") with pin pitch down to 0.4mm (16 mil) Dark background BGA, µBGA, CSP with regular pitches; 6mm - 32mm: Min. ball pitch down to 0.5mm (20mil); Min. ball diameter down to 0.3mm (12mil)		Optional 32mm area CCD camera system with fore and side illumination unit
Mounting accuracy: (X,Y) 3σ	± 50µ for chips 0201 - 0402 ± 75µ for chips and SOIC ± 60µ for QFPs (6mm - 31mm ⍁ 1.26") with pin pitch down to 0.5mm (20 mil)		Line array camera system (all placement heads and all placement angles)
	± 35µ for QFPs (6mm - 32mm ⍁ 1.26") with pin pitch down to 0.4mm (16 mil)		Optional area CCD camera system (in fine mode); one head
Mounting accuracy: (φ) 3σ	For Chips and SOIC this is Lead dependent ± 0.2º for QFPs (6mm - 32mm ⍁ 1.26") with pin pitch down to 0.5mm (20 mil)		Line array camera system (all placement heads and all placement angles)
	± 0.10º for QFPs (6mm - 32mm ⍁ 1.26") with pin pitch down to 0.4mm (16 mil)		Optional area CCD camera system (in fine mode)
Mounting repeatability: 3σ	X, Y 30µ for QFPs (6mm - 32mm ⍁ 1.26") pitch 0.4 Phi (0.075º)		Optional 32mm area CCD camera
Mounting angle:	0 up to 360 (programmable in steps of 0.01)		
Number of heads:	One single beam with 4 Flying Nozzle change heads and 4 standard heads	One single beam with 8 standard heads	The Standard heads can exchange nozzles with the use of the optional Nozzle Exchange Station

	Topaz-X II (FNC)	Topaz-X II (SF)	
			REMARKS
Alignment system:	One line array camera with fore and side illumination system for Vision on the Fly using the VICS 3200 processing system		Standard, second line array camera is optional
	Area CCD camera for QFP 32mm ☐ (1.26") with pin pitch down to 0.4mm (16 mil)		Optional
	Moving CCD camera for Fiducial alignment		Standard
Type of nozzles for X II:	Type 71F (on FNC head) Type 72F (on FNC head) Type 73F (on FNC head) Type 71 Type 72 Type 73 Type 74A Type 76A (Melf nozzle)	Type 71 Type 72 Type 73 Type 74A Type 76A (Melf nozzle)	Standard for the Topaz-X II (FNC) will be delivered: 4x nozzle 71F, 4x nozzle 72F, 4x nozzle 73F, 4x nozzle 72 Standard for the Topaz-X II (SF) will be delivered: 2x nozzle 71, 2x nozzle 72, 2x nozzle 73, 1x nozzle 74A, 1x nozzle 76A
Nozzle exchange station:	18 nozzle positions		Optional (No nozzles included) Nozzle station can hold: 4 x 71, 4 x 72, 4 x 73A, 4 x 74A, 1 x 76A and 1 special nozzle
Component weight:	Max: 10 gr.		With the use of nozzle type 74A
Component height:	Max: 6.5mm	Max: 6.5mm	Line array camera
	Max: 11mm	Max: 11mm	With optional area CCD camera
Component mounting interdistance:	Chip: 0.5mm or more SOP: 0.7mm or more		
Placement system:	Pneumatic or servo controlled for component height compensation		
Placement force:	24 gram/mm (for nozzles with buffer this value is different)		Pre-tension is 200 gr. (spring loaded)
Number of feeders:	Pneumatic Tape Feeders: 8mm: 90 positions 12mm: 43 positions 16mm: 43 positions 24mm: 28 positions 32mm: 22 positions 44mm: 21 positions 56mm: 20 positions Stick feeders: Depends on stick dimensions Bulk feeders: 90 x 8mm positions		For Topaz-X II (FNC) and Topaz-X II (SF) 72mm Tape feeder is available on special request
Number of ITF feeders:	Intelligent Tape Feeders: 8mm: 80 positions 12mm: 36 positions 16mm: 36 positions 24mm: 40 positions 32mm: 24 positions 44mm: 20 positions 56mm: 16 positions Stick feeders: Depends on stick dimensions		For Topaz-Xi II (FNC) and Topaz-Xi II (SF)

	Topaz-X II (FNC)	Topaz-X II (SF)	
			REMARKS
Component packaging:	Tape according to IEC/EIA-J/JEDEC: 8-56mm *For larger tape feeders such as 72mm, please contact your local sales representative.*		Tape reel diameter max: 380mm (15")
	Manual Tray feeder: Max. tray size is board width dependent: Max tray size: 330mm x 300mm (12.8" x 11.7") Max tray size by max board width of 440mm (17.2"): 330mm x 175mm (12.8" x 6.8") Min tray size: 50mm x 50mm (2.0" x 2.0")		Optional: Manual tray feeder (Max. number of feeders 65; Head number 8 can't pick components in an area of 14mm from the right side of the MTF) *Not available for Xi II machines*
	ATS 20 Tray Feeder portrait: Max. tray size: 220mm x 350mm (8.6" x 13.7") Min tray size: 50mm x 50mm (2.0" x 2.0")		Optional (factory built in): ATS 20 Tray Feeder portrait (Max. board width 250mm (9.8"), max. number of 8mm feeders 3 x 20, amount of pallets 20 with 12.5mm pitch)
	Double ATS 20 Tray Feeder portrait: Max. tray size: 220mm x 350mm (8.6" x 13.7") Min tray size: 50mm x 50mm (2.0" x 2.0")		Optional (factory built in): Double ATS 20 Tray Feeder portrait (Max. board width 250mm (9.8"), max. number of 8mm feeders 2 x 20, amount of pallets 2 x 20 with 12.5mm pitch, at the left ATS 20 components can't be picked by all heads in an area of 36mm from the left side of the ATS 20)
	ATS 20 Tray Feeder landscape: Max. tray size: 350mm x 220mm (13.7" x 8.6") Min tray size: 50mm x 50mm (2.0" x 2.0")		Optional (factory built in): ATS 20 Tray Feeder landscape (Max. board width 380mm (15.0"), max. number of feeders 2 x 20 + 16, amount of pallets 20 with 12.5mm pitch, at the right side of ATS components can't be picked by all heads in an area of 18.2mm) *Not possible for Xi II machines*
	Double shuttle LCS Tray Feeder: Max. tray size: 350mm x 440mm (13.7" x 17.2") Min tray size: 50mm x 50mm (2.0" x 2.0")		Optional: Double shuttle LCS Tray Feeder (no restrictions) Max: 120 Jedec trays
	Stick and bulk		Many solutions possible
Maximum height pre-mounted components:	4.0mm on placement side (0.16") 18mm on non placement side (0.7")	6.5mm on placement side (0.26") 18mm on non placement side (0.7")	Before transport
PCB Dimensions (x,y):	Min: 50mm x 50mm (2.0" x 2.0") Max: 460 x 440mm (18" x 17.2") *Special applications upon request, 550mm x 610mm (21.6" x 24")*		Using PCB pin fixation or edge clamping system.
PCB Weight:	Max. 1.2 Kg Max. 2.0 Kg		Without components With components

	Topaz-X II (FNC) Topaz-X II (SF)	
		REMARKS
PCB Thickness:	Min: 0.4mm (0.015") Max: 4.0mm (0.15") *Special applications upon request*	Max. 3.0mm (0.12") with edge clamping system
Non-mountable area:	Board top side: 3mm from rear side board edge (0.12") 0mm from front side board edge	Component height restrictions apply in the 10mm (0.40") area from front side edge depending on board thickness
	4mm around reference holes (0.16") (locate pins)	Flat edge of 30mm (1.2") is required on bottom right corner for the use of the main stopper, sub and exit stopper
	Board bottom side: 5mm from front and rear side board edge (0.2")	
		For ceramic PCBs (optional) the non-mountable area may be different
PCB Material:	Phenolic/FR4/Composite Materials	Ceramic PCBs require special conveyor sections (optional)
PCB Positioning:	Locate pin fixation	Adjustable second pin
	Z servo controlled push up system	Software controlled by PCB thickness
	Push up pins	Adjustable positions
	Edge clamping	With adjustable push in
	Board clamping	Optional
	Sub stop (PCB waiting buffer)	Adjustable position
	Exit stop	Fixed position
PCB Transport height:	900mm ± 10mm (35.4" ± 0.4")	Standard
	SMEMA 953mm ± 12.5mm (37.5" ± 0.5")	Standard
PCB Transport direction:	Left to Right	Right to Left is optional
PCB Transport width:	Automatic	Front rail fixed Rear rail moving
PCB Loading time:	Approximately 3 sec.	PCB loading concurrent to SMD picking and alignment
PCB Ratio width/length:	Max. 1:3	
Control system:	Celeron 566 MHz controller	128 MB internal memory
	Windows NT operating system	
	256 MB flash disk	
	1.44 MB floppy drive 3.5"	
	RS 232 Serial Interface + LAN Interface	
	15" Color User Interface Monitor	12" Flat/touch screen optional (standard for Xi II)
LAN interface:	Based on IEEE802.3u, IEEE802.3	
Communication protocol:	TCP/IP, NetBEUI	

	Topaz-X II (FNC)	Topaz-X II (SF)	
			REMARKS
User interface:	VGOS (Visual Graphical Operating System)		
	Maintenance Support panel for all functions		
	Enhanced PC/AT keyboard for data editing functions		
Control system functions:	Max. 127 PCBs		12,800 components per PCB
	Backup and restoring data using floppy		
	Data conversion Text↔VIOS		
	MIS data gathering		
	Data teaching		
	Data tracing		
	Component database		3000 comp. packages; user can define and teach vision files
	Mark database		300 Mark shapes
	SMEMA electrical interface		
	On line calibration		
	On line help functions		
	Feeder lock verifier		
Machine dimensions and weight:	Length: 1650mm (5.4 ft)		
	Height: 1850mm (6.1 ft)		
	Width: 1408mm (4.5 ft)		Width including feeders: pneumatic feeders 2244mm (7.36 ft), electrical feeders 2150mm (7.05 ft)
	Weight: 1600 kg (3526 Lbs)		
Safety standards:	EN 292, EN 294, EN 349, EN 614, EN 1050, EN 55011, EN 50082-1, EN 60204-1		CE-safety is part of system design. Safety measurements are tested on each product in the factory.
	Electrical safety according IEC 204		
Warning lights:	White: Emergency stop, safety cover interlock Blue: Error mode, e.g. pick up error, out of components Green: in automatic operation		
Audio warning signal:	Operational errors		
Electric power:	Voltage AC: 200/208/220/240/380/400/416 V ± 10%, 3 Phase		More than 3.5mm^2 cables are needed
	Frequency: 50/60 Hz		
	Consumption: 4.4 kVA max.		
Air supply:	Pressure: > 5.5.10^5 Pa (5.5 bar, 80 PSI)		
	Quality: dust and oil free		
	Consumption: 350 Nl/min.		
Operating temperature:	15-35º C (59º - 95º F)		Specification guaranteed: 20º - 28º C (68º - 82º F)
Humidity:	20 - 90% (no dew)		
Noise:	< 78dBa (X); < 74dBa (Xi)		
Clean Room:	Class 10,000 (10 K)		

Table 1

3.0 Features, Accessories and Options

3.1 Features

The standard GEM Topaz-X(i) II includes the following features:

- On the fly alignment using a vision system with a Line Array camera standard equipped with a side illumination unit for BGAs, µBGA, CSP components.
- Placement beam with 4 Flying Nozzle Change heads (each head standard equipped with 3 nozzles) and 4 standard heads or 8 Super Fine heads.
- Simultaneous picking is possible by all 8 heads from any mix of tape feeders (except for 0201 components). This allows a much higher nominal placement rate and board throughput.
- Complete component range can be handled with only 5 nozzles shapes.
- Fiducial alignment camera with improved software controlled illumination unit (white + IR Leds), that also can be used as teaching/tracing device and for Bad Mark sensing.
- Automatic width adjustment. The PCB dimension is included in your PCB data.
- PCB pin-positioning. Second pin is easily adjustable for fast changeover.
- PCB edge clamping system, for PCBs without tooling holes.
- PCB push up plate (Z servo controlled) with 12 push up pins, for PCB support. PCB thickness is included in the PCB data.
- Substopper, allowing a second PCB to enter the machine for reducing transport time.
- Exit Substopper, allowing a new PCB to enter the work area of the machine while the downstream machine is still not ready to accept a new PCB.
- Feeder lock verification system to avoid damage to the machine due to incorrectly latched feeders.
- 3.5" FDD for backup purposes.
- CD-ROM drive for software installation
- Operational panel with push buttons
- Component dump box.
- Operator manual, available in different languages.
- User manual.
- Service manual.
- Two empty tape bins.
- Toolset.
- First aid spare parts kit.
- CE safety.
- ESD safety.
- Electrical and Mechanical SMEMA.

Standard Software features:

- Variable XY axis speed per component.
- Datum angle functionality (especially for stick components, there is no pick angle necessary to recognize the component which results in higher output).
- User Friendly Graphical Human interface VGOS (Visual-Graphical-Operating-System) with touch screen capability.
- An On-line help function allows display of detailed descriptions of operations and functions on screen.
- Management Information System (MIS) to gather production history data.
- 4 point fiducial correction, to maintain accuracy for stretched/distorted boards.
- Template (pattern) matching for PCBs that have no fiducials.
- Different mark shapes for fiducial pair possible.
- Box teaching to recover fiducial recognition error.
- Data editing functions with the use of the fiducial camera (teaching, tracing).
- A Component database, that can hold up to 3000 component packages, with the most frequently used components already predefined.
- A Mark database, that can hold up to 300 mark shapes, with the most frequently used mark shapes already predefined.
- Precede pick-up, allowing to pick up components before the PCB is fixed, reducing cycle time.
- Alternative feeder function, reducing operator intervention (empty feeder switching).
- Automatic program change over for family boards (self production control).
- Automatic rework cycle to improve operator efficiency and on-line optimization, to keep mounting speed during production in case of empty feeders. Detected empty feeders are automatically skipped until end off programs, to allow one time replenishment.
- Product preparation can be done on the machine including basic optimization of the mount program (nozzle and feeder set-up) during production.
- Multi-section PCBs can either be mounted block-by-block or the block data can be combined to achieve the fastest mounting sequence. In the latter case, block badmarks still remain in effect.

3.2 Accessories and Options

Accessories and options Topaz-X II (FNC/SF)	
PA 1912/00	CSM/GEM Glass Adjustment Kit
PA 2505/25	Board Clamping Gem X^{II} series
PA 2505/49	Modification kit for FES 20 position (field retro fit, one machine side)
PA 2505/57	Feederbar exchange system front side, including two FES 20 position cart for FV/GEM ^{II} series

PA 2505/58	Feederbar exchange system rear side, including two FES 20 position cart for FV/GEM II series
PA 2505/59	FES (feederbar exchange system) cart 20 positions for II series
PA 2506/30	Rear side CRT monitor, keyboard and mouse
PA 2506/31	Flat/touch screen monitor, front side
PA 2506/32	Flat/touch screen monitor, rear side
PA 2506/35	Operation panel rear side
PA 2506/40	Maintenance lamp
PA 2695/12	Manual Tray Feeder Topaz-X/Emerald-X
PA 2696/24	ATS 20 Tray Feeder portrait for GEM
PA 2696/25	Double ATS 20 Tray Feeder portrait for GEM
PA 2696/26	ATS 20 Tray Feeder landscape for GEM
PA 2699/23	Double shuttle Tray Feeder (LCS) for II series
PA 2903/27	16mm Tape Feeder, 15 inch reelholder CL
PA 2903/38	24mm Tape Feeder, 15 inch reelholder CL
PA 2903/41	32mm Tape Feeder, 15 inch reelholder FV/GEM PSA
PA 2903/51	44mm Tape Feeder, 15 inch reelholder FV/GEM PSA
PA 2903/77	8mm Tape Feeder for 0201, 2mm pitch, 15 inch reelholder CL
PA 2903/78	8mm Tape Feeder, 2mm pitch, 15 inch reelholder CL
PA 2903/79	8mm Tape Feeder, 4mm pitch, 15 inch reelholder CL
PA 2903/88	12mm Tape Feeder, 15 inch reelholder CL
PA 2904/51	Gem bulk cassette feeder C0603 long
9466 920 10921	Reject belt feeder Gem-X
PA 2923/00	Set of 20 dummy feeders
PA 2962/38	Nozzle Type 71F (for FNC head only)
PA 2962/39	Nozzle Type 72F (for FNC head only)
PA 2962/40	Nozzle Type 73F (for FNC head only)
PA 2962/44	Nozzle Type 74A (Middle size QFP)
PA 2962/45	Nozzle Type 73 (1812 - SOP/4532 - SOP)
PA 2962/46	Nozzle Type 76A Cylindrical chip (MELF)
PA 2962/47	Nozzle Type 71 (0201 - 0402/0603 - 1005)
PA 2962/48	Nozzle Type 72 (0603 - 1206/1608 - 3216)

PA 2963/16	Nozzle Exchange System Topaz-X (FNC) (18 position no nozzles included, factory built-in only)
PA 2969/49	Second Line Array camera for Topaz-X II (factory built-in only)
PA 2969/85	Area CCD camera 32mm (including fore and side illumination unit) for II series
PA 2981/15	Pallet for LCS Tray Feeder FV/GEM (PA 2699/22/23)
PA 2981/35	Pallet for PA 2696/21/24 and PA 2696/22/25 (ATS 20 portrait)
PA 2981/36	Pallet for PA 2696/23/26 (ATS 20 landscape)

Table 2

Accessories and options Topaz-Xi (FNC/SF)	
PA 1912/00	CSM/GEM Glass Adjustment Kit
PA 2505/25	Board Clamping for X II series
PA 2505/52	FES (feederbar exchange) ITF cart 20 positions for II series
PA 2505/53	Feederbar exchange system front side, including two FES 20 position cart for FV/GEM II series
PA 2505/54	Modification kit for FES 20 position for ITF
PA 2505/56	Feederbar exchange system rear side, including two FES 20 position cart for FV/GEM II series
PA 2506/32	Flat/touch screen monitor rear side
PA 2506/35	Operation panel rear side
PA 2506/40	Maintenance lamp
PA 2601/00	Tape Loading Unit
PA 2602/00	Feeder Storage cart
PA 2654/05	Intelligent Tapefeeder 8mm
PA 2654/15	Intelligent Tapefeeder 12mm
PA 2654/25	Intelligent Tapefeeder 16mm
PA 2654/35	Intelligent Tapefeeder 24mm
PA 2654/45	Intelligent Tapefeeder 32mm
PA 2654/55	Intelligent Tapefeeder 44mm
PA 2654/65	Intelligent Tapefeeder 56mm
PA 2696/24	ATS 20 Tray Feeder portrait for GEM

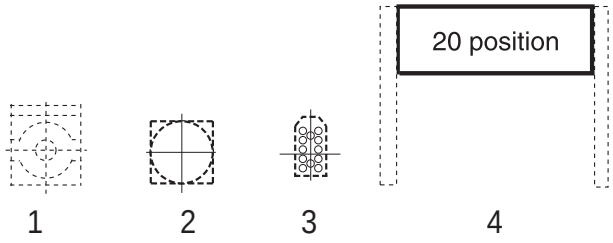
PA 2696/25	Double ATS 20 Tray Feeder portrait for GEM
PA 2699/23	Double shuttle Tray Feeder (LCS) for II series
9466 920 10911	Reject belt feeder Gem-X i
PA 2923/10	Set of 10 ITF dummy feeders
PA 2962/38	Nozzle Type 71F (for FNC head only)
PA 2962/39	Nozzle Type 72F (for FNC head only)
PA 2962/40	Nozzle Type 73F (for FNC head only)
PA 2962/44	Nozzle Type 74A (Middle size QFP)
PA 2962/45	Nozzle Type 73 (1812 - SOP/4532 - SOP)
PA 2962/46	Nozzle Type 76A Cylindrical chip (MELF)
PA 2962/47	Nozzle Type 71 (0201-0402/0603-1005)
PA 2962/48	Nozzle Type 72 (0603-1206/1608-3216)
PA 2963/16	Nozzle Exchange System Topaz-X (FNC) (18 position no nozzles included, factory built-in only)
PA 2969/49	Second Line Array camera for Topaz-X II (factory built-in only)
PA 2969/85	Area CCD camera 32mm (including fore and side illumination unit) for II series
PA 2981/15	Pallet for LCS Tray Feeder FV/GEM (PA 2699/22/23)
PA 2981/35	Pallet for PA 2696/21/24 and PA 2696/22/25 (ATS 20 portrait)
PA 2981/36	Pallet for PA 2696/23/26 (ATS 20 landscape)

Table 3

3.3 Machine configuration examples

On the following pages you can find some machine configuration examples for the Topaz-X(i) II series.

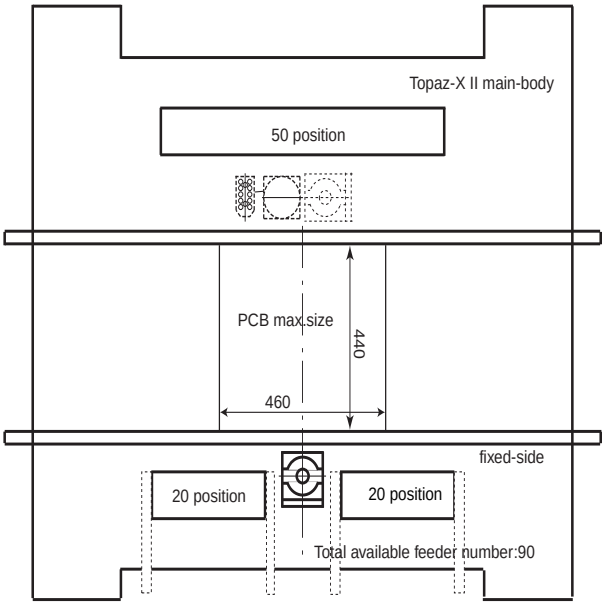
Remark 1: In the examples the dotted lines pictures indicate the physical position of the second line array camera, area CCD camera, nozzle exchange station and FES 20. These can be ordered as an option.



1. Second line array camera.
2. Area CCD camera Topaz-X(i) II.
3. Nozzle exchange station for Topaz-X(i) II.
4. Feederbar Exchange Station 20 position.

Remark 2: By ordering a Feederbar Exchange System for the rear side of the machine, the 50 position feederbar will be replaced by two FES 20 position carts.

EXAMPLE 1: TOPAZ-X II FNC/SF

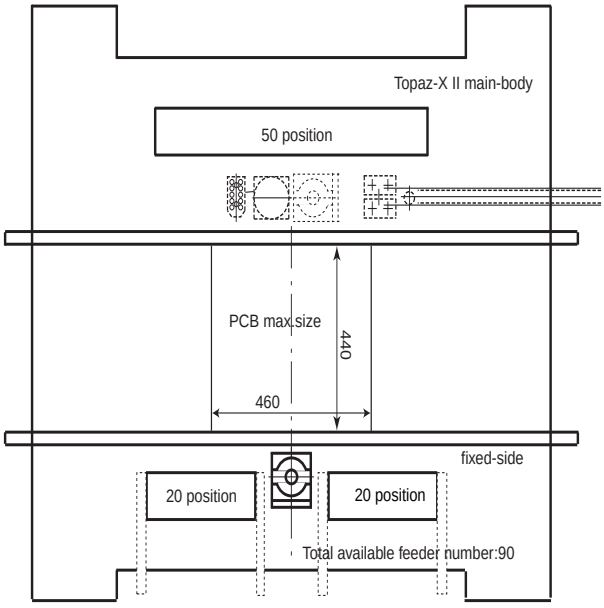


PA 1314/01	Topaz-X II with FNC head
PA 2505/57	Feederbar Exchange system front-side, included FES 20 position carts II serie
PA 2963/16	Nozzle Exchange System Topaz-X (FNC) (18 positions/no nozzles included)
PA 2969/49	Second line array camera Topaz-X II
PA 2969/85	Area CCD camera 32mm (including lighting unit) for II series

Or

PA 1314/02	Topaz-X II with SF head
PA 2505/57	Feederbar Exchange system front-side, included FES 20 position carts II serie
PA 2963/16	Nozzle Exchange System Topaz-X (FNC) (18 positions/no nozzles included)
PA 2969/49	Second line array camera Topaz-X II
PA 2969/85	Area CCD camera 32mm (including lighting unit) for II series

EXAMPLE 2: TOPAZ-X II FNC/SF with double shuttle LCS

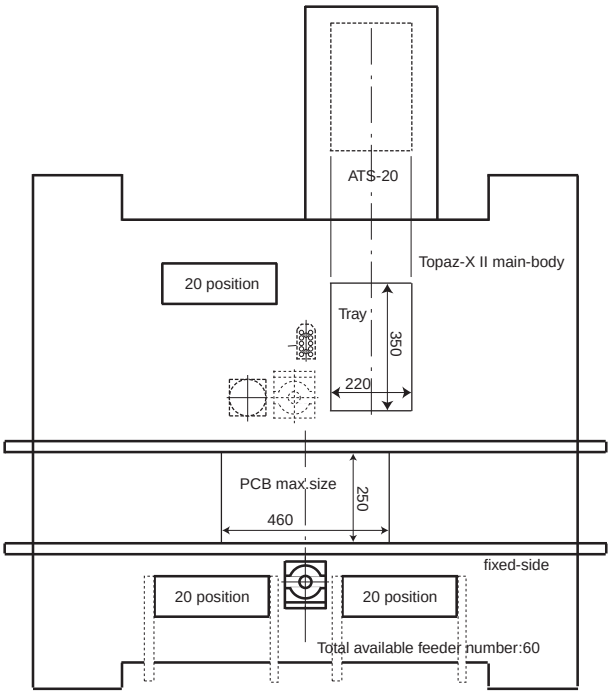


PA 1314/01	Topaz-X with FNC head
PA 2505/57	Feederbar Exchange system front-side, included FES 20 position carts II serie
PA 2699/23	Double shuttle LCS for II serie
PA 2963/16	Nozzle Exchange System Topaz-X (FNC) (18 positions/no nozzles included)
PA 2969/49	Second line array camera Topaz-X II
PA 2969/85	Area CCD camera 32mm (including lighting unit) for II series

Or

PA 1314/02	Topaz-X with SF head
PA 2505/57	Feederbar Exchange system front-side, included FES 20 position carts II serie
PA 2699/23	Double shuttle LCS for II serie
PA 2963/16	Nozzle Exchange System Topaz-X (FNC) (18 positions/no nozzles included)
PA 2969/49	Second line array camera Topaz-X II
PA 2969/85	Area CCD camera 32mm (including lighting unit) for II series

EXAMPLE 3: TOPAZ-X II FNC/SF WITH ATS-20 PORTRAIT

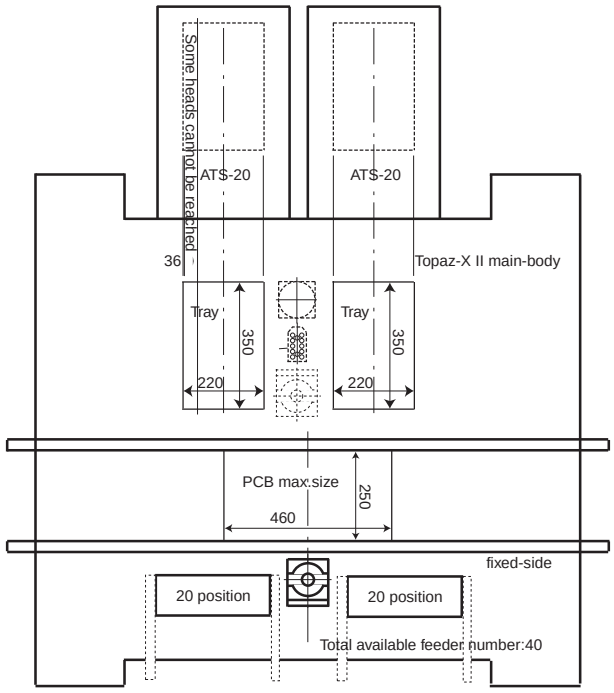


PA 1314/01	Topaz-X II with FNC head
PA 2505/57	Feederbar Exchange system front-side, included FES 20 position carts II serie
PA 2696/24	ATS-20 tray feeder portrait
PA 2963/16	Nozzle Exchange System Topaz-X (FNC) (18 positions/no nozzles included)
PA 2969/49	Second line array camera Topaz-X II
PA 2969/85	Area CCD camera 32mm (including lighting unit) for II series

Or

PA 1314/02	Topaz-X II with SF head
PA 2505/57	Feederbar Exchange system front-side, included FES 20 position carts II serie
PA 2696/24	ATS-20 tray feeder portrait
PA 2963/16	Nozzle Exchange System Topaz-X (SF) (18 positions/no nozzles included)
PA 2969/49	Second line array camera Topaz-X II
PA 2969/85	Area CCD camera 32mm (including lighting unit) for II series

EXAMPLE 4: TOPAZ-X II FNC/SF with double ATS-20 portrait

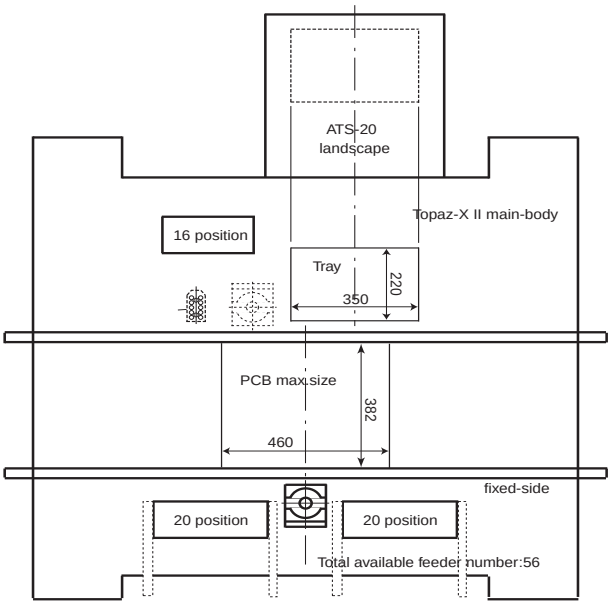


PA 1314/01	Topaz-X II with FNC head
PA 2505/57	Feederbar Exchange system front-side, included FES 20 position carts II serie
PA 2696/25	Double ATS-20 tray feeder portrait
PA 2963/16	Nozzle Exchange System Topaz-X (FNC) (18 positions/no nozzles included)
PA 2969/49	Second line array camera Topaz-X II
PA 2969/85	Area CCD camera 32mm (including lighting unit) for II series

Or

PA 1314/02	Topaz-X II with SF head
PA 2505/57	Feederbar Exchange system front-side, included FES 20 position carts II serie
PA 2696/25	Double ATS-20 tray feeder portrait
PA 2963/16	Nozzle Exchange System Topaz-X (SF) (18 positions/no nozzles included)
PA 2969/49	Second line array camera Topaz-X II
PA 2969/85	Area CCD camera 32mm (including lighting unit) for II series

EXAMPLE 5: TOPAZ-X II FNC/SF with ATS-20 landscape

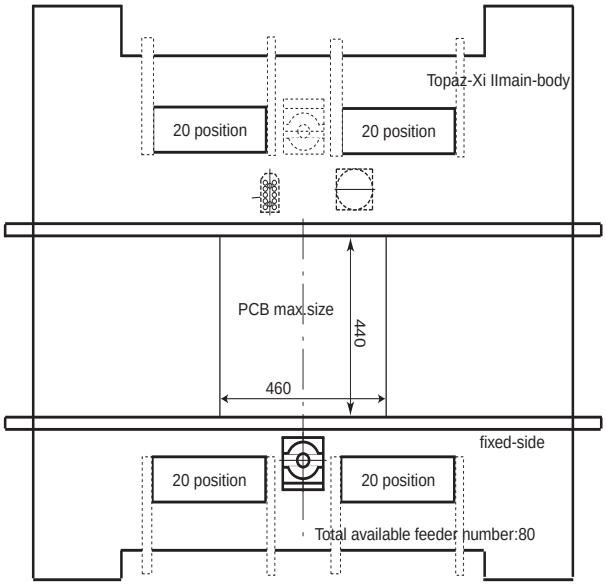


PA 1314/01	Topaz-X II with FNC head
PA 2505/57	Feederbar Exchange system front-side, included FES 20 position carts II serie
PA 2696/26	ATS-20 tray feeder landscape
PA 2963/16	Nozzle Exchange System Topaz-X (FNC) (18 positions/no nozzles included)
PA 2969/49	Second line array camera Topaz-X II or
PA 2969/85	Area CCD camera 32mm (including lighting unit) for II series

Or

PA 1314/02	Topaz-X II with SF head
PA 2505/57	Feederbar Exchange system front-side, included FES 20 position carts II serie
PA 2696/26	ATS-20 tray feeder landscape
PA 2963/16	Nozzle Exchange System Topaz-X (SF) (18 positions/no nozzles included)
PA 2969/49	Second line array camera Topaz-X II or
PA 2969/85	Area CCD camera 32mm (including lighting unit) for II series

EXAMPLE 6: TOPAZ-Xi II FNC/SF

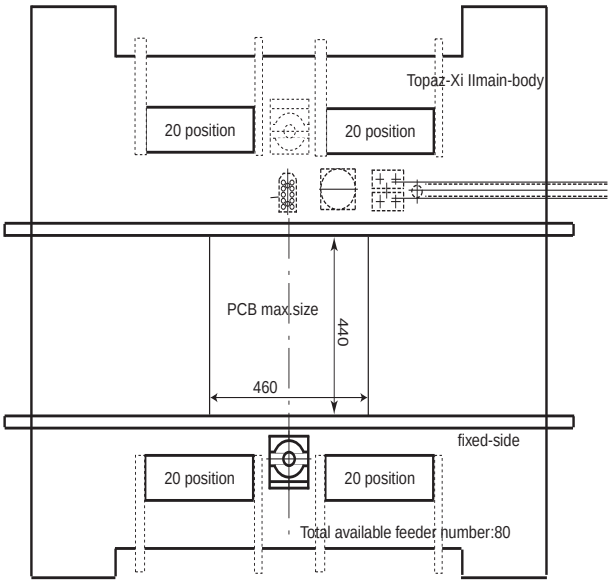


PA 1314/10	Topaz-Xi II with FNC head
PA 2505/53	Feederbar exchange system front side, included FES 20 carts
PA 2505/56	Feederbar exchange system rear side, included FES 20 carts
PA 2963/16	Nozzle Exchange System Topaz-X (FNC) (18 positions/no nozzles included)
PA 2969/49	Second line array camera Topaz-X II
PA 2969/85	Area CCD camera 32mm (including lighting unit) for II series

Or

PA 1314/11	Topaz-Xi II with SF head
PA 2505/53	Feederbar exchange system front side, included FES 20 carts
PA 2505/56	Feederbar exchange system rear side, included FES 20 carts
PA 2963/16	Nozzle Exchange System Topaz-X (SF) (18 positions/no nozzles included)
PA 2969/49	Second line array camera Topaz-X II
PA 2969/85	Area CCD camera 32mm (including lighting unit) for II series

EXAMPLE 7: TOPAZ-Xi II FNC/SF with double shuttle LCS

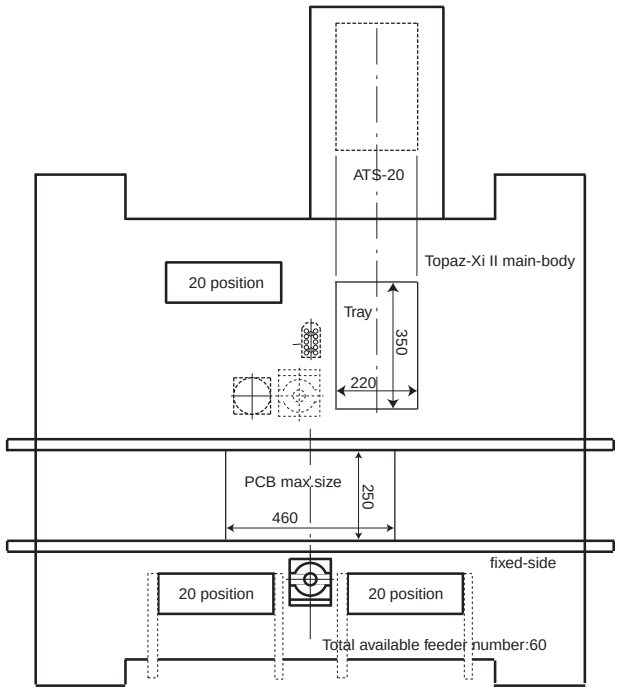


PA 1314/10	Topaz-Xi II with FNC head
PA 2505/53	Feederbar exchange system front side, included FES 20 carts
PA 2505/56	Feederbar exchange system rear side, included FES 20 carts
PA 2699/23	Double shuttle LCS for II serie
PA 2963/16	Nozzle Exchange System Topaz-X (FNC) (18 positions/no nozzles included)
PA 2969/49	Second line array camera Topaz-X II
PA 2969/85	Area CCD camera 32mm (including lighting unit) for II series

Or

PA 1314/11	Topaz-Xi II with SF head
PA 2505/53	Feederbar exchange system front side, included FES 20 carts
PA 2505/56	Feederbar exchange system rear side, included FES 20 carts
PA 2699/23	Double shuttle LCS
PA 2963/16	Nozzle Exchange System Topaz-X (SF) (18 positions/no nozzles included)
PA 2969/49	Second line array camera Topaz-X II
PA 2969/85	Area CCD camera 32mm (including lighting unit) for II series

EXAMPLE 8: TOPAZ-Xi II FNC/SF with ATS-20 portrait

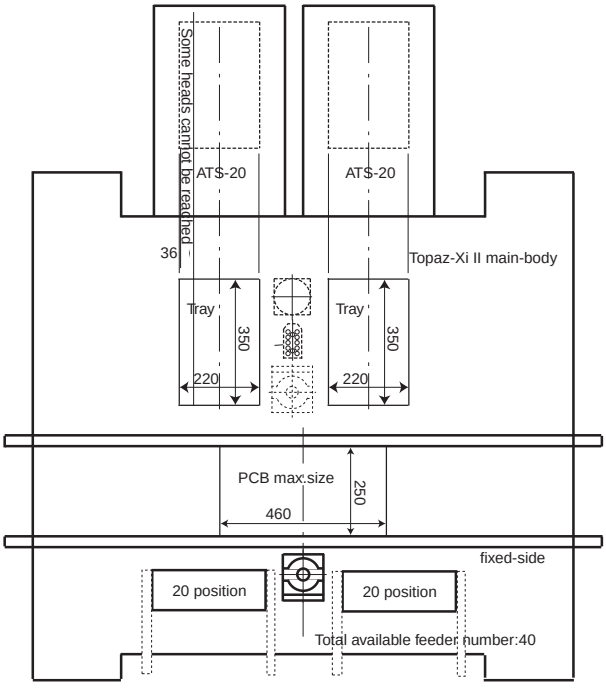


PA 1314/10	Topaz-Xi II with FNC head
PA 2505/53	Feederbar exchange system front side, included FES 20 carts
PA 2696/24	ATS-20 tray feeder portrait
PA 2963/16	Nozzle Exchange System Topaz-X (FNC) (18 positions/no nozzles included)
PA 2969/49	Second line array camera Topaz-X II
PA 2969/85	Area CCD camera 32mm (including lighting unit) for II series

Or

PA 1314/11	Topaz-Xi II with SF head
PA 2505/53	Feederbar exchange system front side, included FES 20 carts
PA 2696/24	ATS-20 tray feeder portrait
PA 2963/16	Nozzle Exchange System Topaz-X (SF) (18 positions/no nozzles included)
PA 2969/49	Second line array camera Topaz-X II
PA 2969/85	Area CCD camera 32mm (including lighting unit) for II series

EXAMPLE 9: TOPAZ-Xi II FNC/SF with double ATS-20 portrait



PA 1314/10 Topaz-Xi II with FNC head
PA 2505/53 Feederbar exchange system front side, included FES 20 carts
PA 2696/25 Double ATS-20 tray feeder portrait
PA 2963/16 Nozzle Exchange System Topaz-X (FNC) (18 positions/no nozzles included)
PA 2969/49 Second line array camera Topaz-X II
PA 2969/85 Area CCD camera 32mm (including lighting unit) for II series

Or

PA 1314/11 Topaz-Xi II with SF head
PA 2505/53 Feederbar exchange system front side, included FES 20 carts
PA 2696/25 Double ATS-20 tray feeder portrait
PA 2963/16 Nozzle Exchange System Topaz-X (SF) (18 positions/no nozzles included)
PA 2969/49 Second line array camera Topaz-X II
PA 2969/85 Area CCD camera 32mm (including lighting unit) for II series

4.0 Mounting Heads Configuration

The Topaz-X(i) II features a high precision single placement beam carrying 4 Flying Nozzle Change heads (each equipped with 3 nozzles) and 4 standard heads with exchangeable nozzles or 8 Super Fine heads with exchangeable nozzles. On both head models (FNC, SF) a separate camera system is attached that monitors fiducial marks at the board, circuit and component level, using white + IR light LEDs and multi-angle diffusers to provide optimal illumination. High placement rates are achieved by simultaneous component picking which reduces head beam travel and thus shortens the mounting cycle.

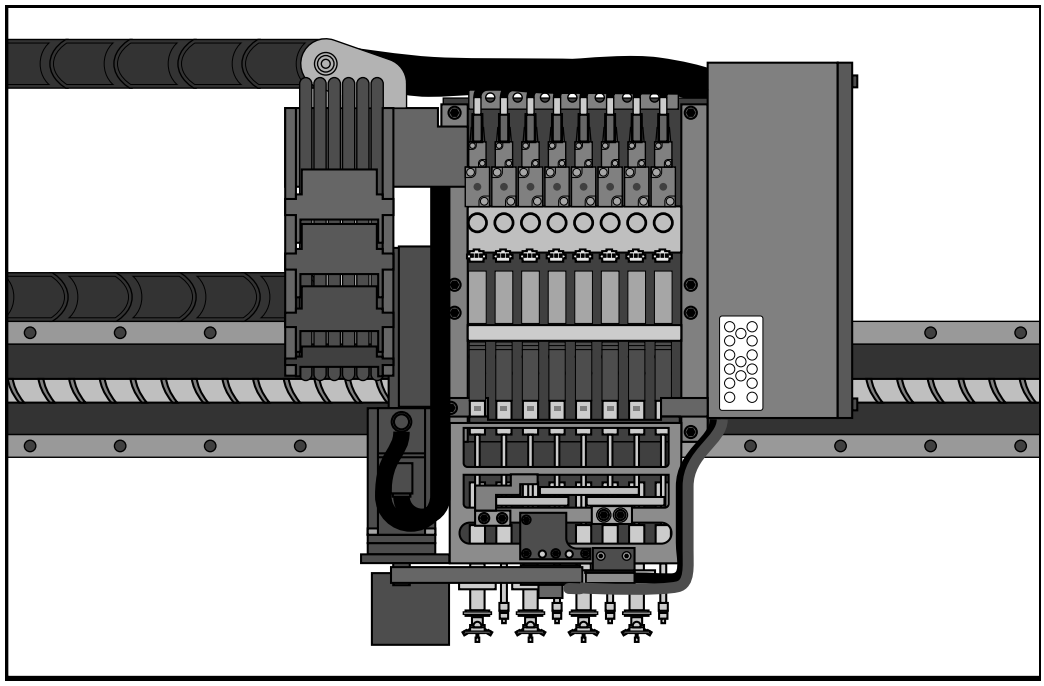


Figure 2 *Configuration of head section.*

The high-precision dual Y drive Topaz-X(i) II features four-axis (X, Y, Z, R) servo control for accurate, stress-free component mounting. Direct drive, brushless AC motors controlling heavy duty lead screws allow optimal accuracy and high reliability.

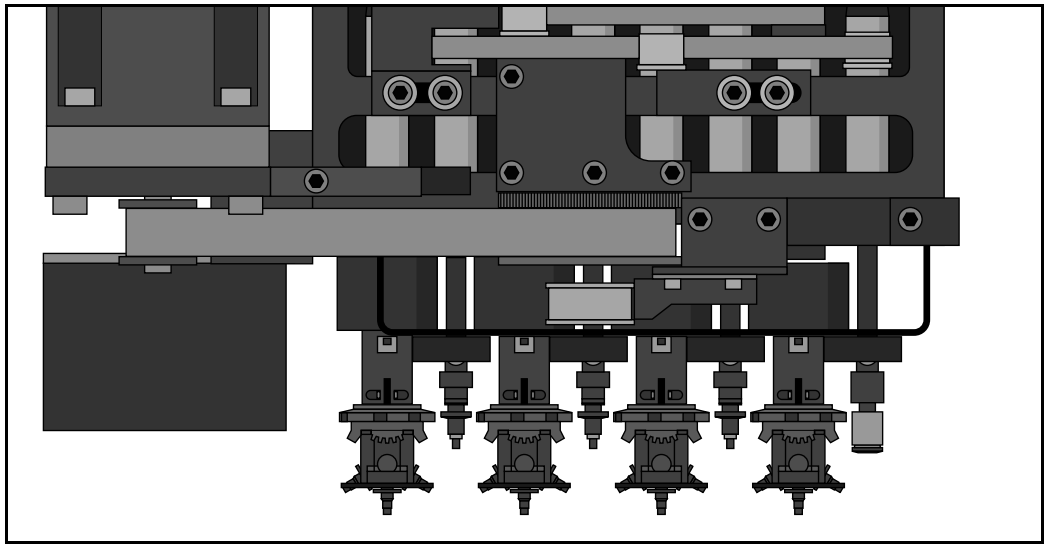


Figure 3 *Head section FNC detail*

Specifications	
Number of axis:	7
Axis configuration:	X axis AC servo Double Y axis AC servo Z , R axis AC servo W (automatic width) axis AC servo Push up plate AC servo
Z axis sequence:	Air and AC servo motor
R axis sequence:	AC servo motor
Pick-up error detection:	Vacuum check (256 level digital setting)
Mounting angle:	0° - 360° (0.01° step)
Number of mounting head:	8 in-line multi head, FNC or SF
Nozzle types:	5 different shapes
Encoder resolution:	X,Y = 0.0012mm/pulse
	Phi = 0.0146°/pulse
	Z = 0.00048mm/pulse
Head position accuracy:	X = 0.010mm
	Y = 0.010mm
Speed:	X = 1500mm/sec
	Y = 1500mm/sec
Acceleration:	X = 36600mm/sec^2
	Y = 27000mm/sec^2

Table 4

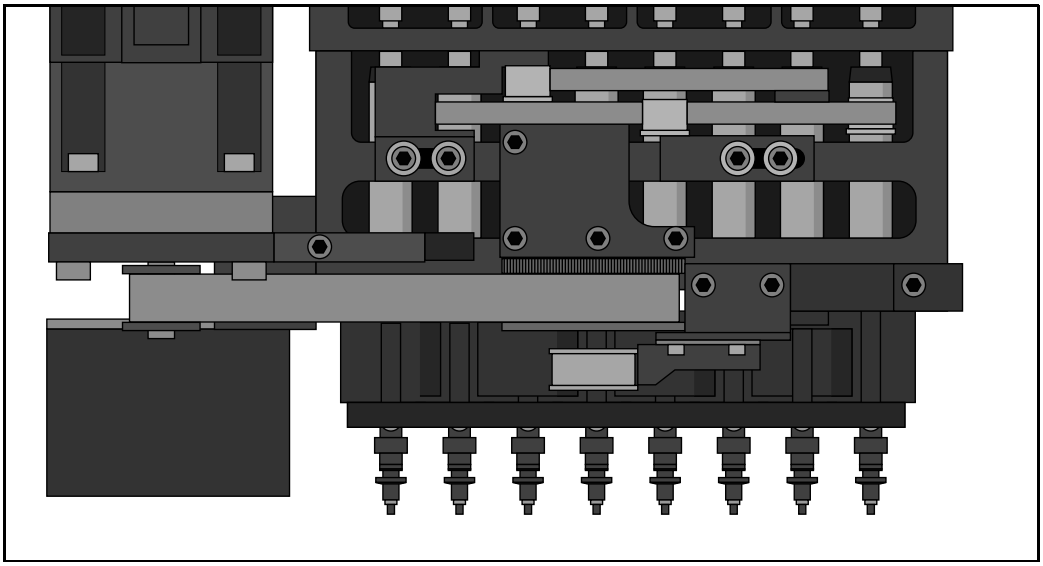


Figure 4 *Head section SF detail.*

5.0 Alignment

5.1 Line Array Camera Alignment

The high speed of the Topaz-X(i) II is achieved by fast on-the-fly component alignment using a revolutionary Line Array camera system, equipped with a newly developed multi angle illumination unit, that is four times faster than conventional vision systems. For ultimate speed, the machine can be equipped with a second Line Array camera which reduces head beam travel and thus shortens the mounting cycle.

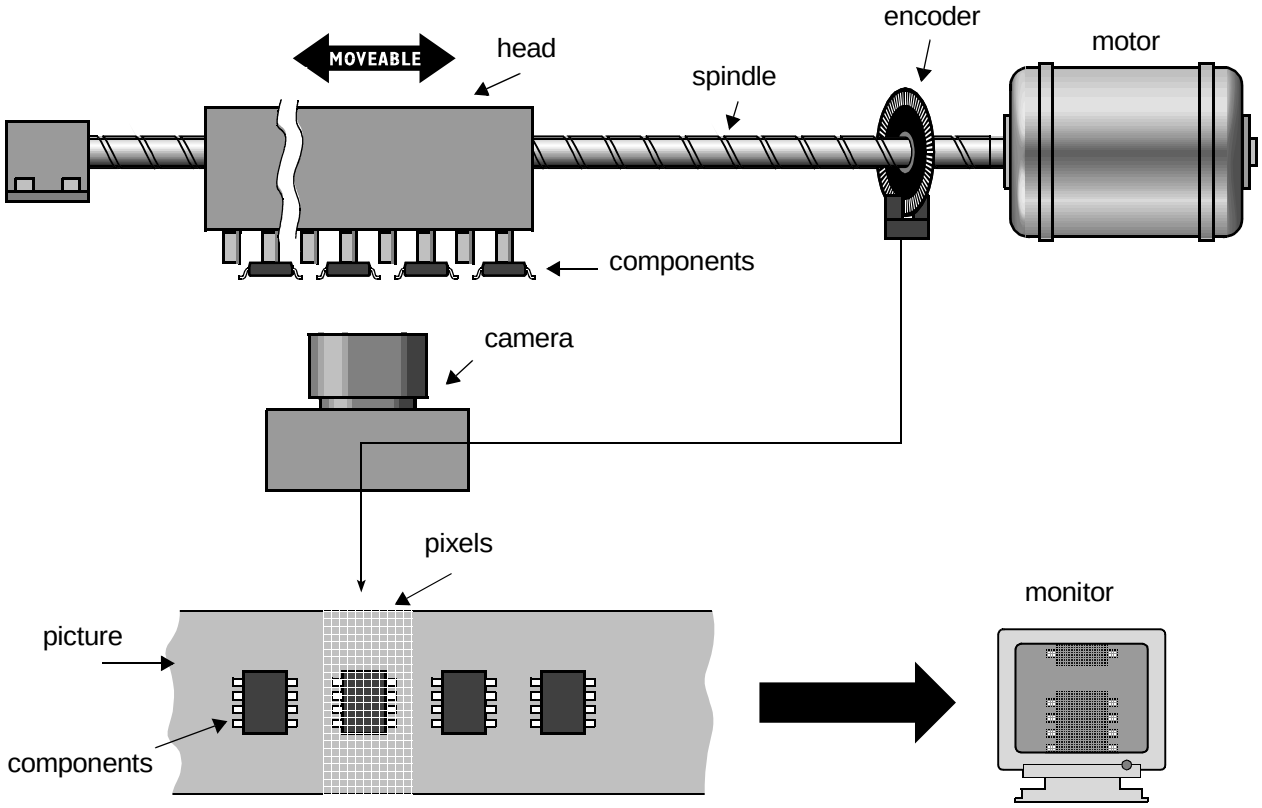


Figure 5 *Line sensor vision principle.*

While moving the beam over the camera, the encoder triggers the camera to capture consecutive lines of pixels. All these lines form the total picture of the components. This picture is processed by a sophisticated vision system. The vision system algorithms inspect the components and calculate position and orientation of the components on the heads.

The SMD components are illuminated by a new developed multi angle side illumination unit which allows high speed recognition of CSPs and µBGAs. The leads of the components are imaged on the line sensor.

Specifications		
Line Array camera:	CCD 1024 x 1 pixels	
Max. component size:	32mm ⍁ (1.26")	45mm ⍁ (1.77")
Min. component size:	0201	
Min. lead pitch:	0.4mm (16 mil)	0.5mm (20 mil) > 32mm 0.4mm (16 mil) < 32mm
Min. lead width:	0.2mm (0.008")	
Grey scale:	256 levels	
Lighting:	Multi angle Fore/side illumination (red LED array); Light intensity is software controlled for each component separately	
Recognition:	Reflection. Pattern recognition on all leads	
Max. number of lead sides:	4	
Max. number of lead groups:	2 per side	
Check on:	Lead/ball pitch	
	Lead/ball location	
	Bent/missing leads/balls	
	Total number of leads/balls	
	Cumulative lead/ball pitch	

Table 5

5.2 Single Area CCD Alignment

An optional single area CCD camera extends the component range for the Topaz-X(i) II.

Component illumination is performed by means of fore/reflective lighting and side illumination. The lighting source reflects the lead of QFP and the balls of BGA components on the CCD camera. The single area CCD camera grabs the image of the component in one frame and presents it to the vision system for recognition and measurements purposes.

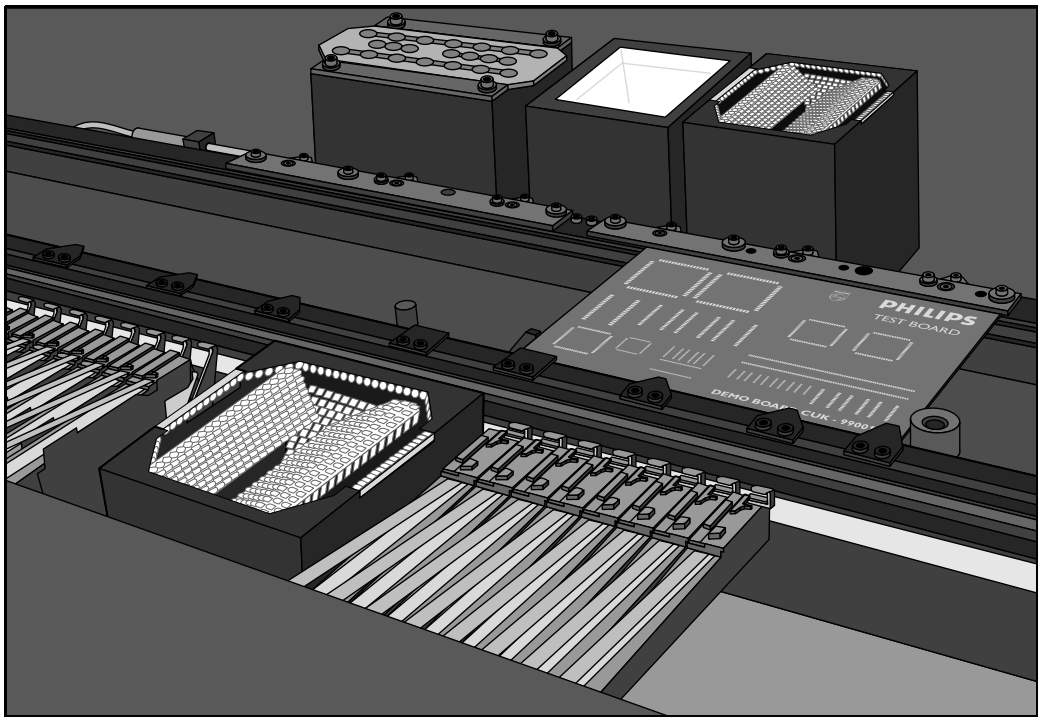


Figure 6 *GEM Topaz-X(i) II working area.*

Specifications	
Area CCD Camera:	CCD 512 x 480 pixels
Max. component size:	32mm ⌀ (1.26")
Min. component size:	6mm ⌀ (0.24")
Min. lead pitch:	0.4mm (16 mil)
Min. lead width:	0.2mm (0.008")
Grey scale:	256 levels
Lighting:	Fore/side lighting illumination
Recognition:	Reflection. Pattern recognition on all leads
Max. number of lead sides:	4
Max. number of lead groups:	2 per side
Check on:	Lead/ball pitch
	Lead/ball location
	Bent/missing leads/balls
	Total number of leads/balls
	Cumulative lead/ball pitch

Table 6

5.3 Fiducial Alignment

The Topaz-X(i) II is standard equipped with a fiducial camera. This camera is used to compensate for variations in the position of the circuit pattern relative to the expected position. The fiducial alignment system is an opto-electronic system which performs geometric measurements of fiducial marks on the PCB in order to calculate the deviations from their expected positions. The system can use two or four fiducials per board. Each sub-circuit can also be aligned using two fiducials. For placement of fine-pitch components two local fiducials per component may be used. The individual shapes of a fiducial pair can be different to allow for maximum application flexibility. Also pattern recognition algorithms can be used on traces or pads on the PCB board for cases where fiducials are not available.
The fiducial camera can also be used as a high accurate teaching device for PCB data (if CAD data is not available), automatic calibration and inspection purposes.

Specifications	
Fiducial camera:	CCD
Fiducial camera functionality	Fiducial detection, Bad Mark detection, teaching device (2 or 4 point teaching)
Fiducial illumination:	White + IR LEDs in conjunction with a wide-angle diffuser
Compensation for: (with two fiducials)	Translation Rotation Linear stretch and shrink
Compensation for: (with 3 or 4 fiducials)	Non-linear stretch and shrink
Type of compensation:	PCB, Block, Local
Fiducial size:	Max. 3.0mm (0.12")
	Min. 0.8mm (0.03")
Fiducial material:	Copper Gold Lead-tin
Fiducial clearance area	2 x Fiducial size
PCB warpage at fiducial:	Max. 0.5mm (0.02")
Pattern offset:	Max. 1mm (0.04")
Number of different Fiducial pairs per PCB:	128
Number of fiducial shapes in Mark Database:	300
Examples of fiducials:	Solid circle (preferred) Square Triangle Donut Binary cross Bow-tie (connected) Template matching
Fiducial definition:	According CAD data

Table 7

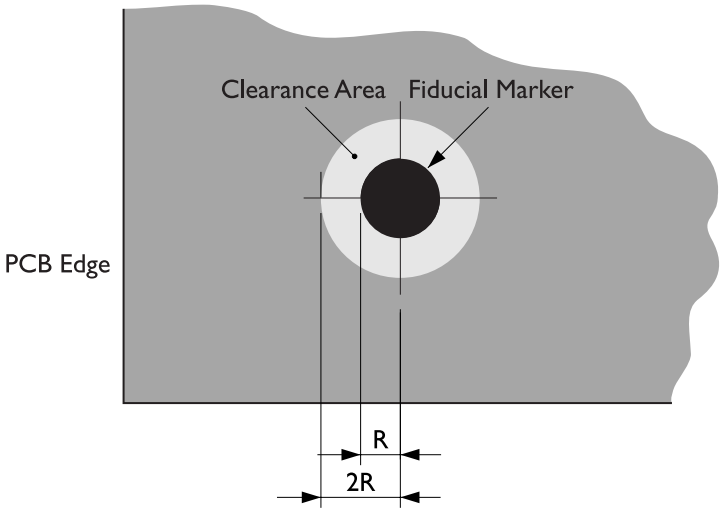
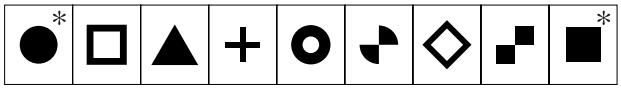


Figure 7 *Fiducial free space.*



* Preferred; others possible but not preferred

Figure 8 *Fiducials.*

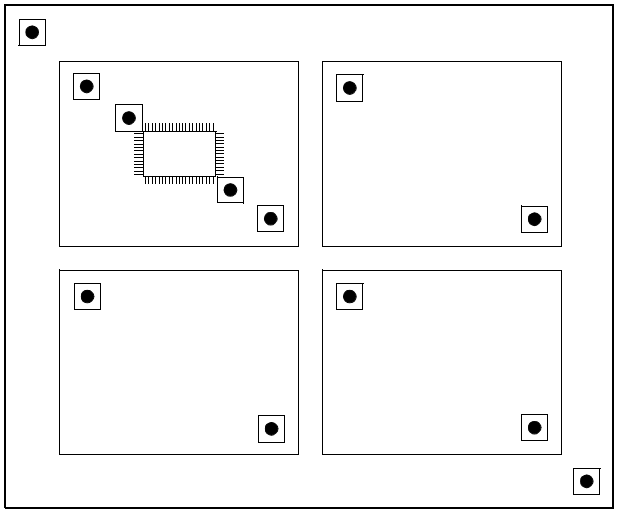


Figure 9 *Examples of PCB, block and local fiducials.*

5.4 Master, Bad Mark Sensing

If the PCB contains subcircuits, one or more of these subcircuits can be skipped for placement by giving them a 'Bad Mark' on a designated position on the subcircuit. No parts will be placed on a circuit that has a Bad Mark. Bad Mark sensing, with the use of the fiducial camera, is based on recognition of a difference in contrast in a certain area. This area can be defined in the machine software (position and area-dimensions). This gives maximum freedom in choosing the process or technique to add Bad Marks, for example:

- white or light colored labels of any dimension,
- white paint,

... or any other material that can be fixed as long as it contrasts with the PCB surface.

Before checking the Bad Marks on all circuits, the Master Mark may be checked first. Presence of a Master Mark means that one or more Bad Marks are present on the circuits. This allows the machine to skip the Bad Mark sensing process for all circuits if no Bad Marks are located on the circuits, therefore saving valuable production time.

6.0 Board Handling

PCB boards can be located in the machine by either tooling pins, edge clamping or board clamping if tooling holes are not available. With pin location, one location pin is fixed on the machine while the other locate pin is easily adjustable when the board length changes. Change over to a different board size is just a matter of seconds by using the automatic adjustment (servo controlled) of the conveyor width and the PCB thickness.

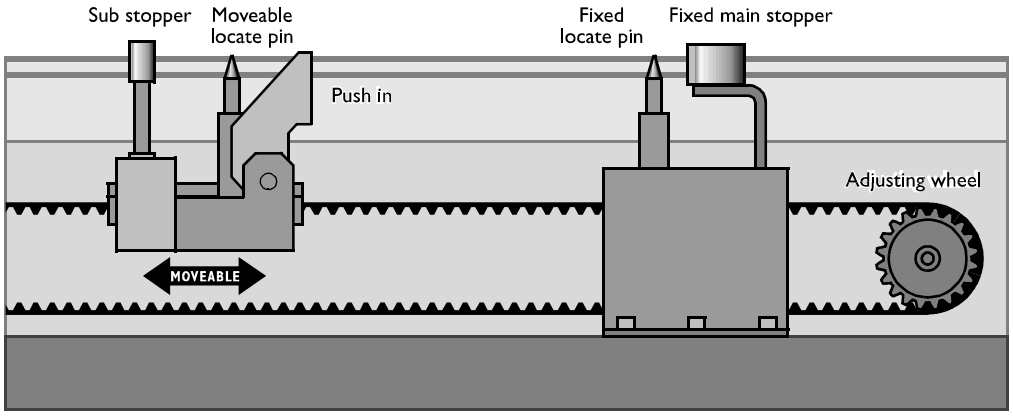


Figure 10 *Pin fixation system.*

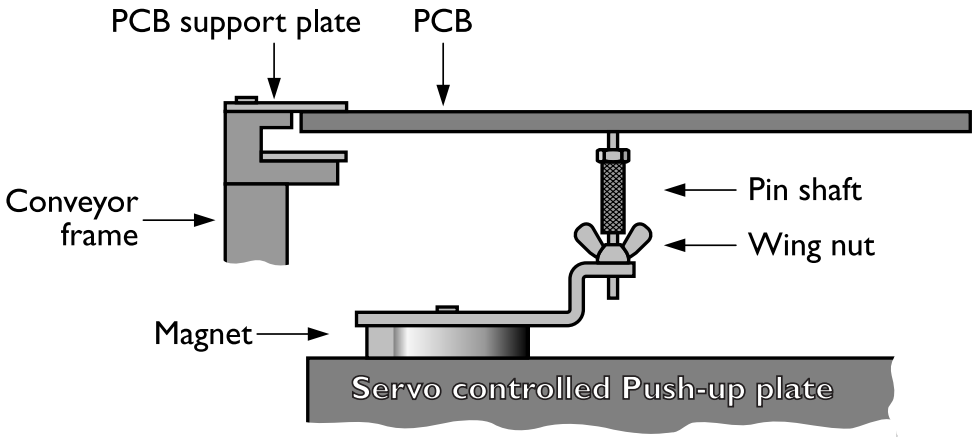


Figure 11 *Push up system.*

The Edge Clamping system is as easy to adjust as the locate pin fixation. Both these systems use Push-up pins to support the PCB.

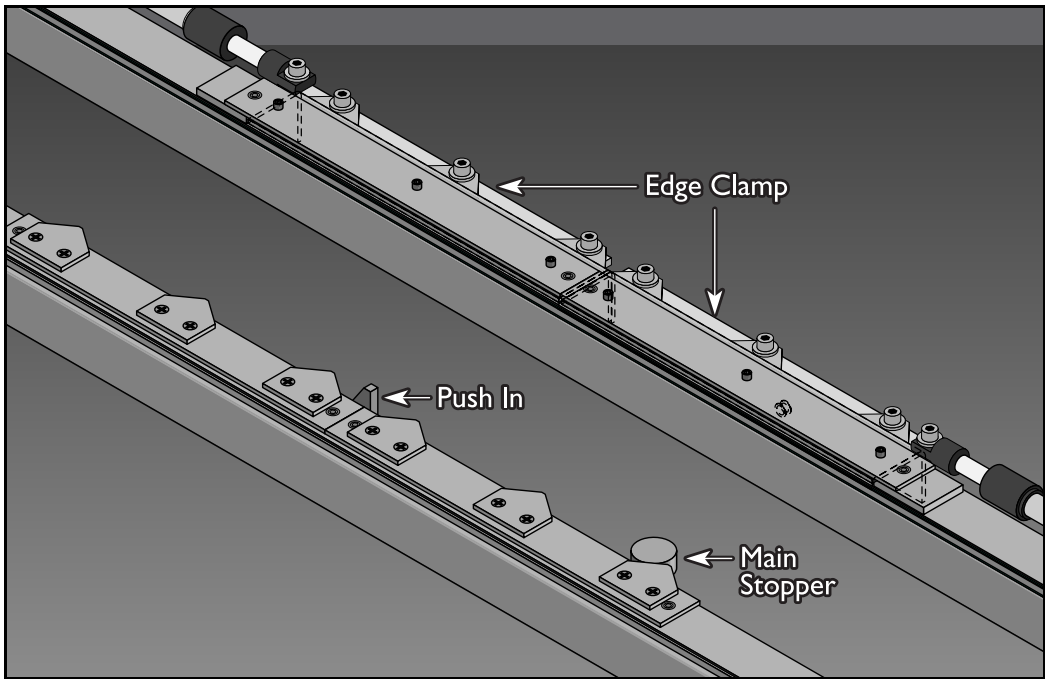


Figure 12 *GEM Topaz-X(i) II Edge Clamping system.*

A sub-stop enables an additional PCB to enter the machine while the current board is being populated. This reduces time loss during transport and is very useful when operating the machine in a flowline. An exit sub-stop, which can be seen as a transport buffer function, links the entrance sub-stop and main stopper, shortening the PCB transport time and reducing loss from inefficient operation.

When using the machine in a flowline, it communicates with the unit upstream and downstream over a SMEMA-connection.

Specifications	
PCB Dimensions (x,y):	Min. 50mm x 50mm (2.0" x 2.0")
	Max. 460mm x 440mm (18" x 17.2") using PCB pin fixation or PCB edge clamping, board clamping system
PCB Thickness:	Min. 0.4mm (0.015")
	Max. 4.0mm (0.15"); max. 3.0mm (0.12") with PCB edge clamping system
Reference hole position:	5mm (0.2") in X and Y from lower right corner
Reference hole diameter:	Ø 2.0mm-Ø 4.0mm (0.08" - 0.157")
PCB Maximum warpage:	0.5mm up (0.02") 1.0mm down (0.04")

Specifications	
Max. height pre-mounted components:	4mm on placement side (0.16") for FNC head 6.5mm on placement side (0.26") for SF head 18mm on non placement side (0.7")
Non-Mountable area:	Board Top side: 3mm from rear side board edge (0.12") 0mm from front side board edge (Component height restrictions apply in the 10mm (0.40") area from front side edge depending on board thickness) 4mm around reference holes (0.16") (locate pins)
	Board Bottom side: 5mm from front and rear side board edge (0.2")
PCB Material:	Phenolic/FR4/Composite Materials Ceramic PCB transport is optional
PCB weight:	Max. 1.2 Kg without components Max. 2.0 Kg with components
PCB positioning:	Locate pin fixation (adjustable second pin) Z servo controlled push up system (software controlled by PCB thickness) Push up pins (adjustable positions) Edge clamping (with adjustable push in) Board clamping (optional) Sub stop (PCB waiting buffer) adjustable position Exit stop (fixed position)
PCB Transport height:	900mm ± 10mm (35.4" ± 0.4") SMEMA 953mm ± 12.5mm (37.5" ± 0.5")
PCB Transport direction:	Left to Right standard, optional Right to Left
PCB Transport width:	Automatic
PCB loading time:	Approximately 3 sec.
PCB ratio width/length:	Max. 1:3

Table 8

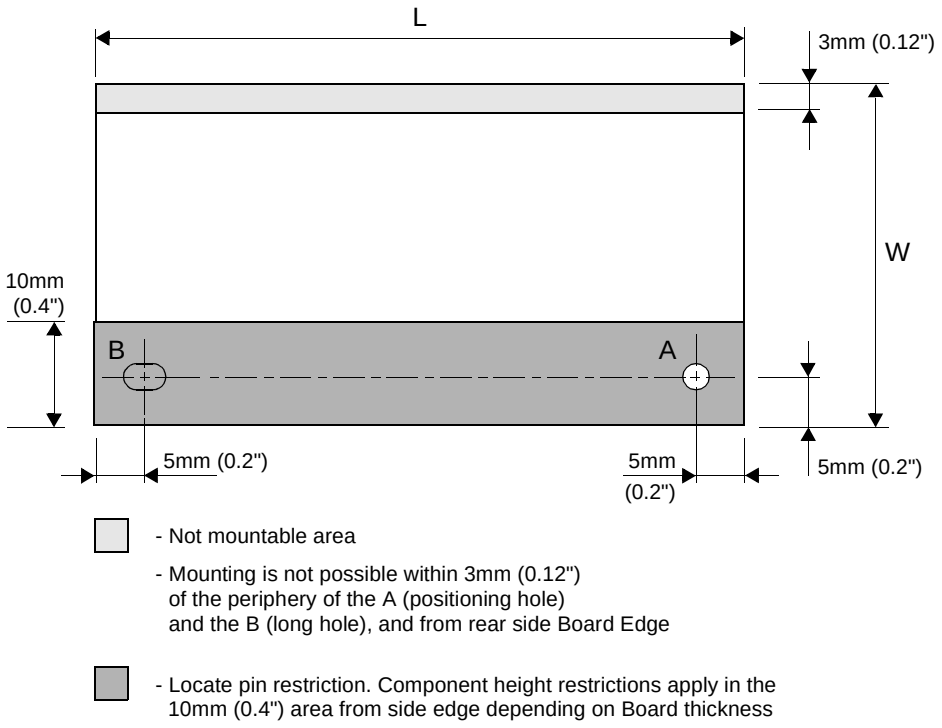


Figure 13 *Mountable area.*

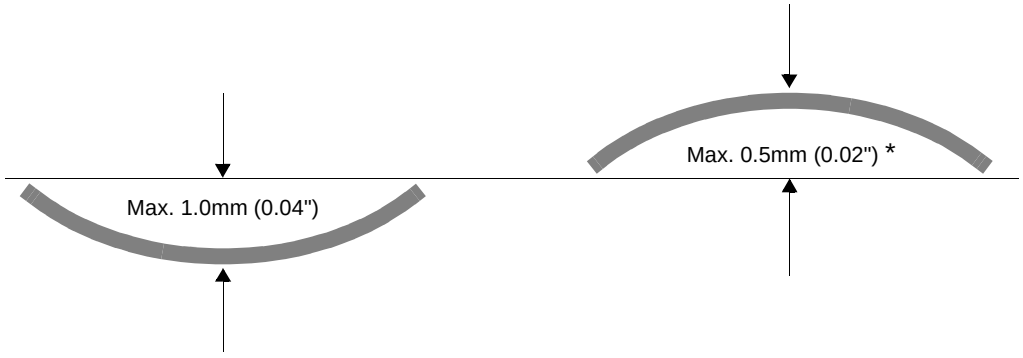


Figure 14 *Warp of fixed PCB.*

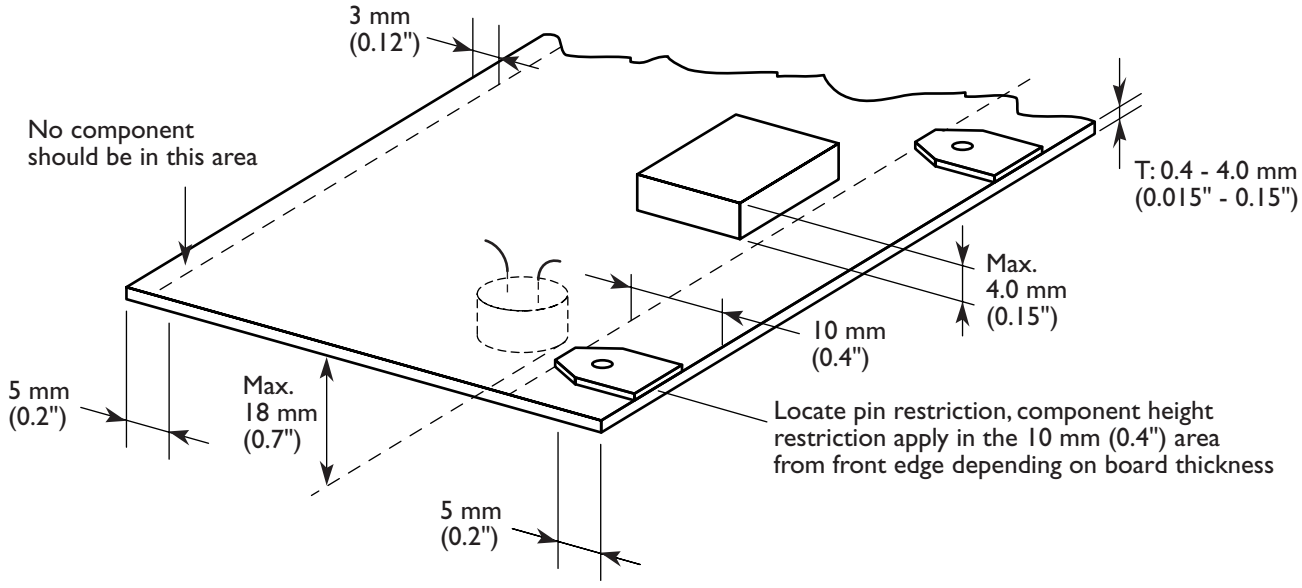


Figure 15 *Mountable area.*

7.0 Feederbar Exchange System

7.1 PA 2505/52

The Feederbar Exchange System (FES) allows fast change-over by switching the complete 20 position feederbar on a Topaz-Xi II.

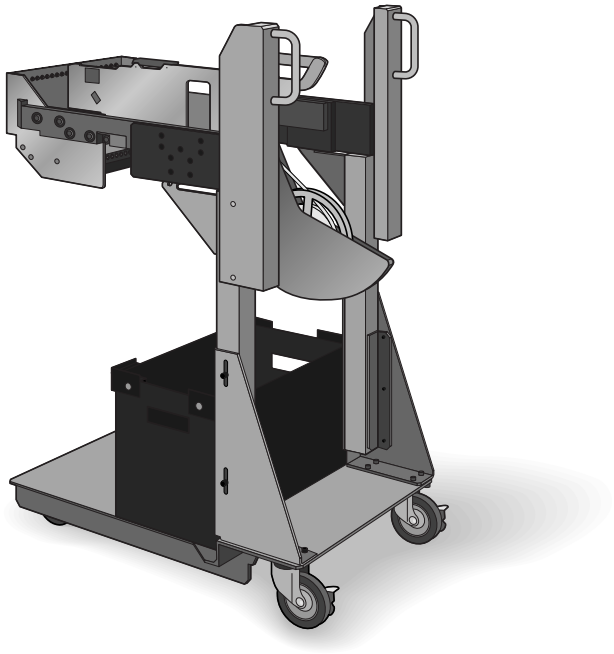


Figure 16 *FES-cart Xi*

Feederbars are mounted on carts to off-line feeder Set-up. These carts are easily moved from set-up area to the mounting machines and back. This option is available for the front (PA 2505/53) and rear side (PA 2505/56) of the machine.

The Topaz-Xi II FES carts are compatible with those of the Topaz-Xi, Emerald-Xi and Emerald-Xi II. An empty tape bin will be delivered with each FES cart.

FES 20 specifications	
	PA 2505/52
FES change-over time:	≤ 60 sec.
FES accuracy from FES cart fiducials to pick position ($\mu + 3\sigma$)	X = +/- 0.05mm Y = +/- 0.05mm Z = +/- 0.10
Applicable feeders:	ITF tape feeders ITF stick feeders

Number of feeders on FES carriage:	8 mm: 20 positions 12/16 mm: 9 positions 24 mm: 10 positions 32 mm: 6 positions 44 mm: 5 positions > 56 mm: 4 positions Stick: depends on stick dimensions
Air and Electrical interface:	Quick coupling (one action)
Electrical power:	Supplied by main system
Air supply:	No air supply to feeders
FES 20 dimensions, stand alone without feeders:	Length: 820 mm (2.7 ft) Width: 470 mm (1.55 ft) Height: 1050 mm (3.44 ft)
Weight without feeders:	55 kg (121 Lbs)
Tape waste bin :	Included
Compatibility:	Topaz-Xi, Emerald-Xi and Emerald-Xi II
Min. component size:	0402 (1.0mm x 0.5mm) Smaller components should be used with pick-up teaching function.

Table 9

7.2 PA 2505/59

The Feederbar Exchange System (FES) allows fast change-over by switching the complete 20 position feederbar on a Topaz-X II.

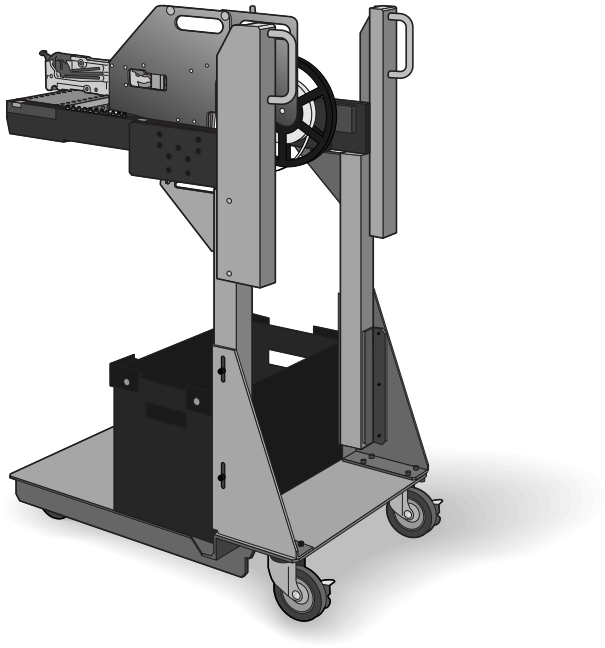


Figure 17 *FES-cart X*

Feederbars are mounted on carts to off-line feeder Set-up. These carts are easily moved from set-up area to the mounting machines and back. This option is available for the front (PA 2505/57) and rear side (PA 2505/58) of the machine. At the rear side of the machine the standard 50 position feederbar will be replaced by two FES 20 position carts.

The Topaz-X II FES carts are compatible with those of the Emerald-X II. An empty tape bin will be delivered with each FES cart.

FES 20 specifications	
	PA 2505/59
FES change-over time:	≤ 60 sec.
FES repeatability	Pick position ≤ 0.05mm
Applicable feeders:	Tape, stick, bulk feeders
Number of feeders on FES carriage:	8 mm: 20 positions 12/16 mm: 9 positions 24 mm: 6 positions 32 mm: 6 positions 44 mm: 4 positions > 56 mm: 4 positions Stick: depends on stick dimensions
Air and Electrical interface:	Quick coupling (one action)
Electrical power:	Supplied by main system
Air supply:	Supplied by main system
FES 20 dimensions, stand alone without feeders:	Length: 750 mm (2.5 ft) Width: 460 mm (1.5 ft) Height: 1000 mm (3.3 ft)
Weight without feeders:	65 kg (143 Lbs)
Tape waste bin :	Included
Compatibility:	Emerald-X II
Min. component size:	0402 (1.0mm x 0.5mm) Smaller components should be used with pick-up teaching function.

Table 10

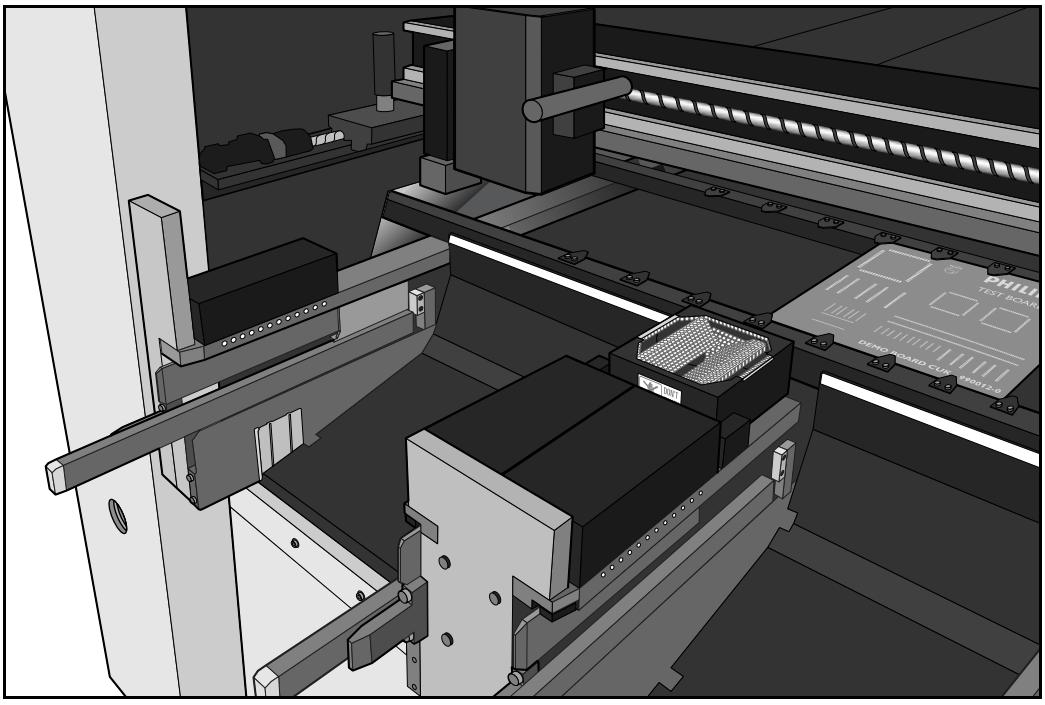


Figure 18 *Clamping System*

8.0 Component Feeding

8.1 Pneumatic Tape feeders

The Topaz-X II has a fully compatible feeder platform with all machines, Sapphire, Topaz, Topaz-X, Emerald, Emerald-X and Emerald-X II. Depending on the machine configuration up to 90 tape feeders (8mm) can be loaded.
The tape feeder design allows simultaneous picking from any mix of tape feeders ranging from 8 to 44mm. To achieve high speed feeding all feeder types are air driven. To prevent incorrect feeder latching, a laser-based verification system is used.

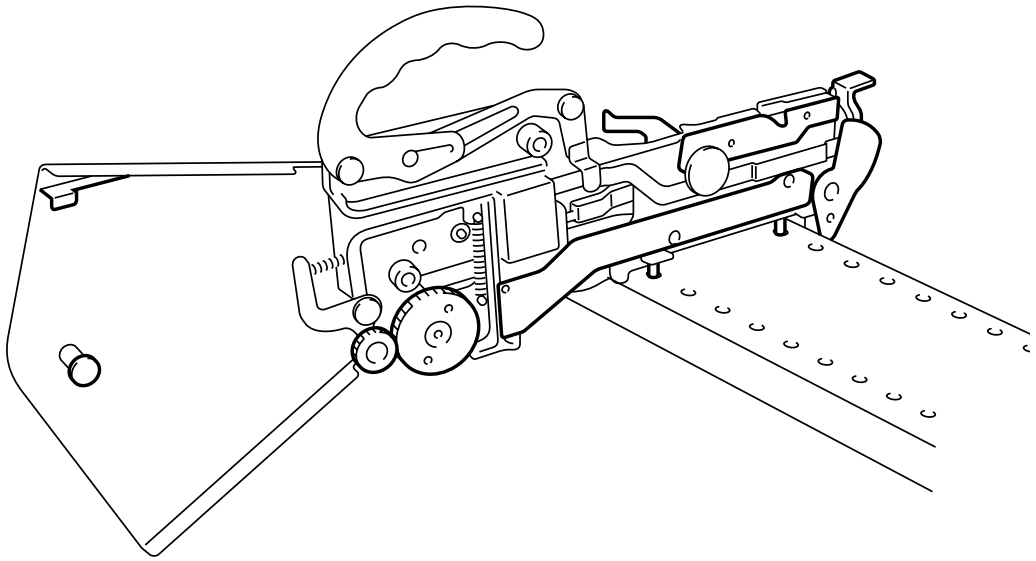


Figure 19 *Pneumatic Tape Feeder*

Available tape feeders		
Tape Feeder	**Feeding pitch (mm)**	**PA#**
Tape Feeder 8mm 15" for 0603 (0201) component CL	2	PA 2903/77
Tape Feeder 8mm 15" for 1005 (0402) CL	2	PA 2903/78
Tape Feeder 8mm 15" CL	4	PA 2903/79
Tape Feeder 12mm 15" CL	4, 8, 12	PA 2903/88
Tape Feeder 16mm 15" CL	4, 8, 12, 16	PA 2903/27
Tape Feeder 24mm 15" CL	4, 8, 12, 16, 20, 24	PA 2903/38
Tape Feeder 32mm 15" (PSA)	8, 12, 16, 24, 28, 32	PA 2903/41
Tape Feeder 44mm 15" (PSA)	8, 12, 16, 24, 28, 32, 36	PA 2903/51
Tape Feeder 56mm 15" CL	4, 8, 12, 16, 20	PA 2903/68
For larger and special tape feeders such as 72mm please contact your local sales representative.		

Table 11 *The feeding pitch can be adjusted on the feeder side.*

Feeder occupation	
Feeder type	**Required feeder position equivalent to tape feeder 8mm**
Tape Feeder 8mm	1
Tape Feeder 12mm, 16mm, 24mm	3
Tape Feeder 32mm	4
Tape Feeder 44mm	5
Tape Feeder 56mm	6

Table 12

The above feeder conversion number may differ according to the installation combination.

8.2 Intelligent Tape feeders

The Topaz-Xi II has a fully compatible feeder platform with the Topaz-Xi, Emerald-Xi, Emerald-Xi II, ACM and FCM Line machines. Depending on the machine configuration up to 80 Intelligent Tape Feeders (8mm) can be loaded.
Intelligent tapefeeders are available for 8 up to 56mm tape widths. The feeders can be loaded with 13 inch tape reels (optional 15" is available).
ITF feeders are indexed by an electrical driven mechanism allowing a highly reliable uninterrupted feeding process.
To prevent incorrect feeder latching, a laser-based verification system is used.
To load the tapes into the ITF feeders a Tape Loading Unit is required. The TLU can be used without main power supply, a battery pack (12V DC) allows 'stand alone' operation for about 8 hours.

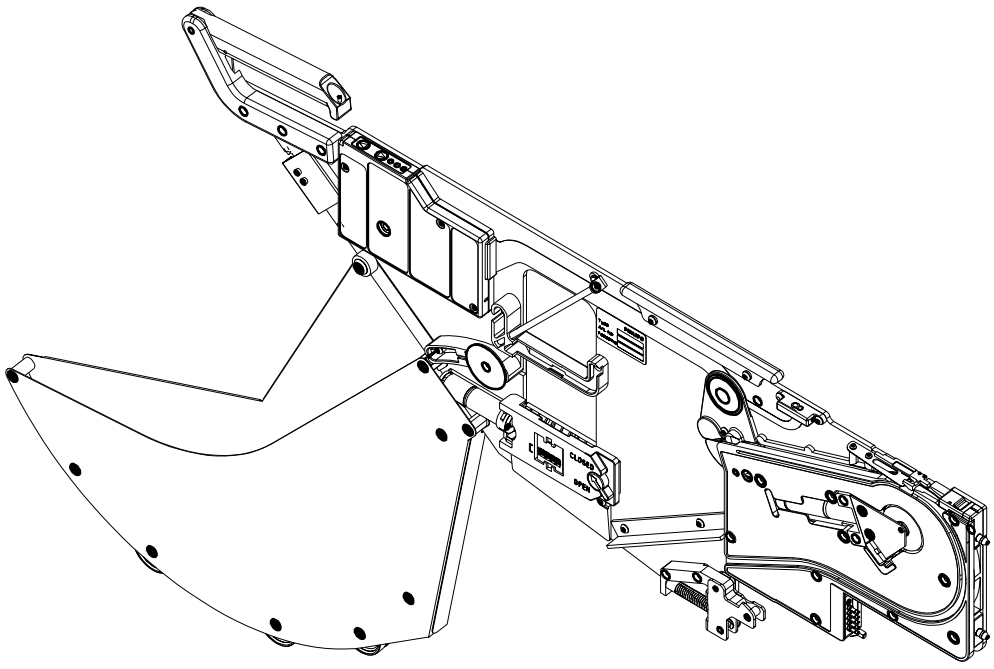


Figure 20 *Intelligent Tape Feeder*

Available tape feeders		
Tape Feeder	**Feeding index (mm)**	**PA#**
Intelligent Tape Feeder 8mm	2, 4, 8, 12, 16, 20, 24, 28, 32, 40, 44, 48, 52, 56	PA 2654/05
Intelligent Tape Feeder 12mm	2, 4, 8, 12, 16, 20, 24, 28, 32, 40, 44, 48, 52, 56	PA 2654/15
Intelligent Tape Feeder 16mm	2, 4, 8, 12, 16, 20, 24, 28, 32, 40, 44, 48, 52, 56	PA 2654/25
Intelligent Tape Feeder 24mm	2, 4, 8, 12, 16, 20, 24, 28, 32, 40, 44, 48, 52, 56	PA 2654/35
Intelligent Tape Feeder 32mm	2, 4, 8, 12, 16, 20, 24, 28, 32, 40, 44, 48, 52, 56	PA 2654/45
Intelligent Tape Feeder 44mm	2, 4, 8, 12, 16, 20, 24, 28, 32, 40, 44, 48, 52, 56	PA 2654/55
Intelligent Tape Feeder 56mm	2, 4, 8, 12, 16, 20, 24, 28, 32, 40, 44, 48, 52, 56	PA 2654/65

Table 13 *The feeding pitch can be adjusted on the feeder side.*

Feeder occupation	
Feeder type	**Required feeder position equivalent to tape feeder 8mm**
Tape Feeder 8mm	1
Tape Feeder 12mm	3
Tape Feeder 16mm	3
Tape Feeder 24mm	2
Tape Feeder 32mm	4
Tape Feeder 44mm	4
Tape Feeder 56mm	5

Table 14 *The above feeder conversion number may differ according to the installation combination.*

8.3 Double Shuttle Tray Feeder (PA 2699/23)

The double shuttle Tray feeder is an additional pallet sequencer feeding parts from a tray. This feeder can be equipped with maximum 40 pallets, each being able to hold different trays.

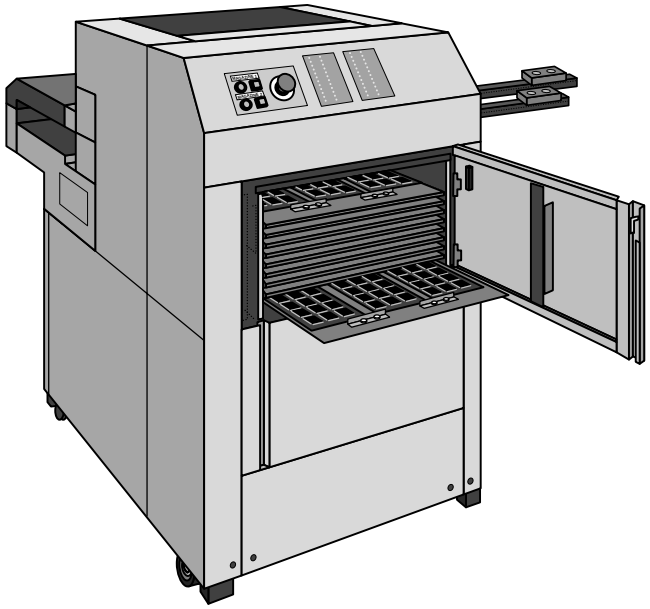


Figure 21 *Double shuttle Tray Feeder.*

Two components are picked up from the tray with a double head, and placed simultaneously on a shuttle. This shuttle then moves into the machine where the components are picked by the placement head. The part is then aligned by vision and placed on the PCB. At the same moment when the components are picked by the placement head a second shuttle will be supplied with the next components which minimize the feeding time.

The component feeding time of the double shuttle Tray feeder is 3.5 seconds for 2 parts when using the same tray (pallet 1) and 8.5 seconds when changing the tray (pallet 40). However, in practice no time is lost because of the simultaneous operation of Tray sequencer and Topaz-X(i) II: while the machine is picking from on-board feeders, the shuttle brings in new components. A part that is rejected by vision will be placed back on the reject conveyor which means no loss of expensive parts.

The PCB conveyor on the double shuttle Tray feeder offers the possibility for visual PCB inspection.

- A tray container is fixed and separated into two sections with each 20 pallets. This allows tray replenishment while the machine is running.
- A buffer conveyor is standard equipped, so a reflow oven can be connected without additional conveyors.

LCS Tray Feeder specifications	
GENERAL	
Max. Tray size (L x W):	350mm x 468mm (13.7" x 18.4"); which can hold 3 Jedec trays
Min. Tray size (L x W):	50mm x 50mm (2.0" x 2.0")
Component feeding time	3.5 sec. for 2 parts (picking from pallet 1) 8.5 sec. for 2 parts (picking one from pallet 1 and one from pallet 40)
Power and air supply:	Delivered by Topaz-X(i) II
LCS Tray feeder dimensions:	Length: 826mm (2.8 ft) Height: 1165mm (3.8 ft); with top cover open 1545mm (5.2 ft) Width: 1650mm (5.2 ft); with door open 2292mm (7.6 ft)
Topaz-X(i) II + Tray feeder dimensions:	Length: 2476mm (8.3 ft) Height: 1850mm (6.1 ft) Width: 1842mm (6.1 ft); with LCS door open and feeders on Topaz-X(i) II 2942mm (9.8 ft)
Weight:	± 280 kg (617 Lbs)
Power supply, air supply	Supplied from main machine
APPLICABLE COMPONENTS	
Min. Component dimension:	8mm x 8mm (0.31" x 0.31") Mold size
Max. Component dimension:	45mm x 45mm (1.8" x 1.8")
Max. Tray height included component height:	8.5mm (0.33") from pallets at pitch of 12.5mm (0.5"), total 40 pallets possible
	20mm (0.78") from pallets at pitch of 25mm (0.98"), total 20 pallets possible

LCS Tray Feeder specifications	
FEED CAPACITY	
Number of shuttles:	2
Number of pads on each shuttle:	2 (with a pitch of 48mm)
STANDARD COMPONENT CAPACITY	
Max. number of component types:	120 (3 x 40 Jedec)
Number of pallets:	Standard 40 pallets included (additional pallets available PA 2981/15)

Table 15

8.4 ATS 20 Tray Feeder portrait (PA 2696/24)

The ATS 20 Tray Feeder is a new additional internal pallet sequencer, allowing high-speed feeding of tray components. This feeder can be equipped with a maximum of 20 pallets, each being able to hold different trays.

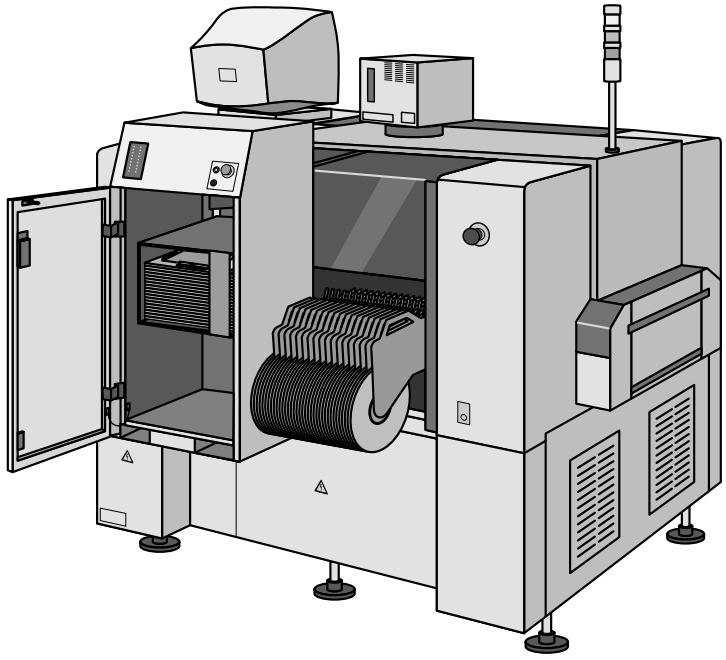


Figure 22 *ATS 20 Tray Feeder portrait.*

The maximum pallet exchange time for the ATS 20 Tray feeder is 5.6 seconds. However, in practice no time is lost because of the simultaneous operation of the ATS 20 Tray feeder and Topaz-X(i) ^{II}; while the machine is picking from on-board feeders, the pallet brings in new components.

A part rejected by vision will be placed back in its original tray position; this means no loss of expensive parts.

ATS 20 Tray Feeder portrait (PA 2696/24) specifications	
GENERAL	
Max. Tray size (L x W):	220mm x 350mm (8.6" x 13.7").
Min. Tray size (L x W):	50mm x 50mm (2.0" x 2.0")
Pallet exchange time:	Changing from pallet 1 to 20; 5.6 seconds
Weight:	± 80 Kg (176 Lbs)
Power and air supply:	Supplied by Topaz-X(i) II
Topaz-X(i) II + ATS 20 Tray feeder dimensions:	Length: 1650mm (5.5 ft) Height: 1850mm (6.2 ft) Width: 1870mm (6.2 ft); with ATS 20 door open: 2220mm (7.4 ft)
Maximum board size Topaz-X(i) II:	250mm (9.8")
Maximum amount of feeders on Topaz-X(i) II:	60
APPLICABLE COMPONENTS	
Max. Tray height included component height:	8.5mm (0.33") from pallets at pitch of 12.5mm (0.49"); total 20 pallets possible.
	16mm (0.63") from pallets at pitch of 25mm (0.98"); total 10 pallets possible.
Min. Component dimension:	6mm x 6mm (0.24" x 0.24") mold size
Max. Component dimension:	32mm x 32mm (1.3" x 1.3")
STANDARD COMPONENT CAPACITY	
Max. number of component types:	20 (20 x 1 Jedec tray)
Number of pallets:	Standard 20 pallets included (additional pallets available PA 2981/35)

Table 16

8.5 Double ATS 20 Tray Feeder portrait (PA 2696/25)

The Double ATS 20 Tray Feeder portrait is a new additional internal pallet sequencer, allowing high-speed feeding of tray components. This feeder can be equipped with a maximum of 2 x 20 pallets, each being able to hold different trays.

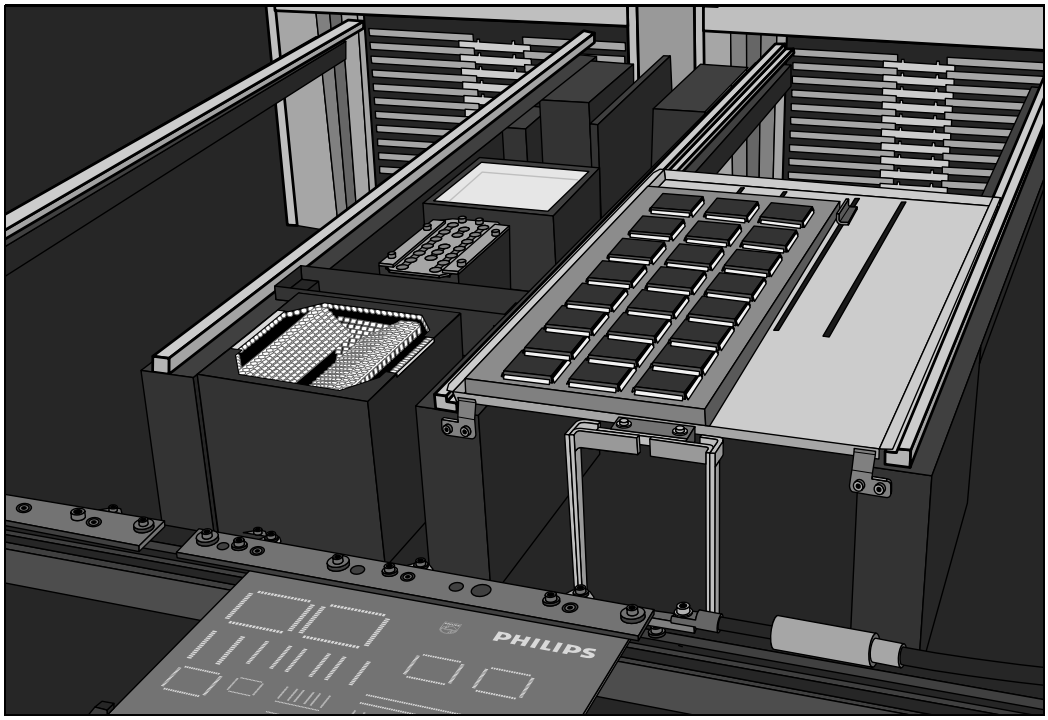


Figure 23 *Double ATS 20 Tray Feeder portrait.*

The maximum pallet exchange time for the Double ATS 20 Tray feeder is 5.6 seconds. However, in practice no time is lost because of the simultaneous operation of the Double ATS 20 Tray feeder and Topaz-X(i) ^{II}; while the machine is picking from on-board feeders, the pallet brings in new components.

A part rejected by vision will be placed back in its original tray position; this means no loss of expensive parts.

Double ATS 20 Tray Feeder portrait (PA 2696/25) specifications	
GENERAL	
Max. Tray size (L x W):	220mm x 350mm (8.6" x 13.7").
Min. Tray size (L x W):	50mm x 50mm (2.0" x 2.0")
Pallet exchange time:	Changing from pallet 1 to 20; 5.6 seconds
Pick up restrictions:	At the left ATS 20 components can't be picked by all heads in an area of 36mm (1.4")from the left side of the pallet.
Power and air supply:	Supplied by Topaz-X(i) II
Weight:	± 160 Kg (342 Lbs)
Topaz-X(i) II + double ATS 20 Tray feeder dimensions:	Length: 1650mm (5.5 ft) Height: 1850mm (6.2 ft) Width: 1870mm (6.2 ft); with ATS 20 door open: 2220mm (7.4 ft)
Maximum board size Topaz-X(i) II:	250mm (9.8")
Maximum amount of feeders on Topaz-X(i) II:	40
APPLICABLE COMPONENTS	
Max. Tray height included component height:	8.5mm (0.33") from pallets at pitch of 12.5mm (0.49"); total 20 pallets possible.
	16mm (0.63") from pallets at pitch of 25mm (0.98"); total 10 pallets possible.
Min. Component dimension:	6mm x 6mm (0.24" x 0.24") mold size
Max. Component dimension:	32mm x 32mm (1.3" x 1.3")
STANDARD COMPONENT CAPACITY	
Max. number of component types	40 (40 x 1 Jedec tray)
Number of pallets:	Standard 2 x 20 pallets included (additional pallets available PA 2981/35)

Table 17

8.6 ATS 20 Tray Feeder landscape (PA 2696/26)

The ATS 20 Tray Feeder landscape is a new additional internal pallet sequencer, allowing high-speed feeding of tray components. This feeder can be equipped with a maximum of 20 pallets, each being able to hold different trays.

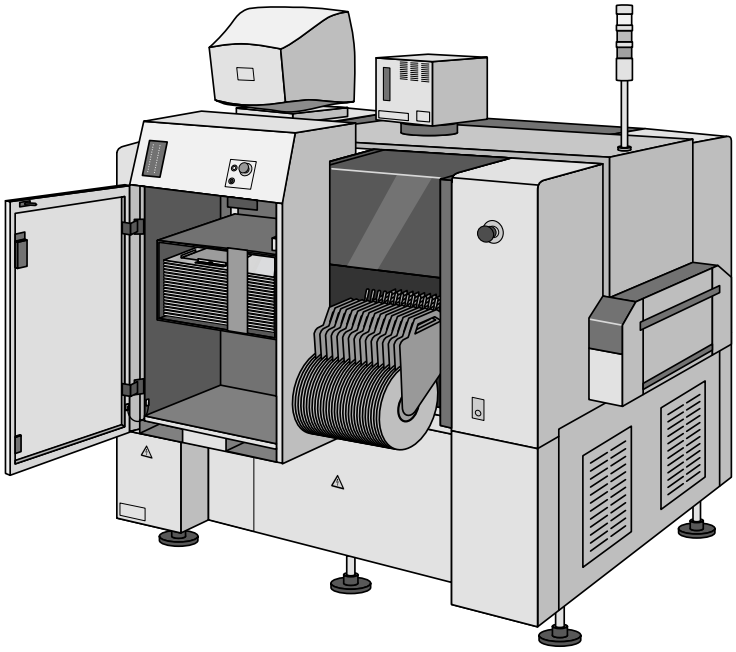


Figure 24 *ATS 20 Tray Feeder landscape.*

The maximum pallet exchange time for the ATS 20 Tray Feeder landscape is 5.6 seconds. However, in practice no time is lost because of the simultaneous operation of the ATS 20 Tray Feeder landscape and Topaz-X II; while the machine is picking from on-board feeders, the pallet brings in new components.

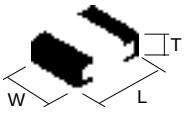
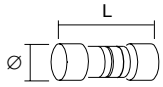
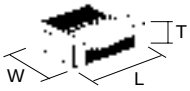
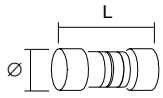
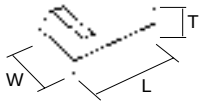
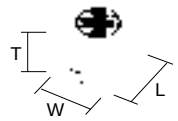
A part rejected by vision will be placed back in its original tray position; this means no loss of expensive parts.

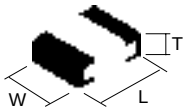
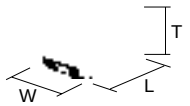
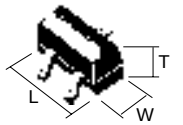
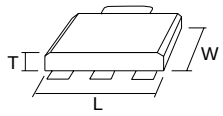
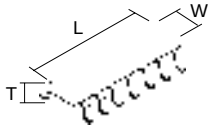
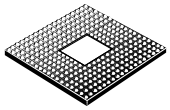
ATS 20 Tray Feeder landscape (PA 2696/26) specifications	
GENERAL	
Max. Tray size (L x W):	350mm x 220mm (13.7" x 8.6").
Min. Tray size (L x W):	50mm x 50mm (2.0" x 2.0")
Pallet exchange time:	Changing from pallet 1 to 20; 5.6 seconds
Pick up restrictions:	At the right side of the ATS 20 landscape pallet components can't be picked by all heads in an area of 18.2mm (0.72").
Power and air supply:	Supplied by Topaz-X II
Weight:	± 80 Kg (176 Lbs)
Topaz-X II + Landscape ATS 20 Tray feeder dimensions:	Length: 1650mm (5.5 ft) Height: 1850mm (6.2 ft) Width: 1783mm (5.9 ft); with ATS 20 door open: 2283mm (7.6 ft)
Maximum board size Topaz-X II:	380mm (15.0")
Maximum amount of feeders on Topaz-X II:	56
APPLICABLE COMPONENTS	
Max. Tray height included component height:	8.5mm (0.33") from pallets at pitch of 12.5mm (0.49"); total 20 pallets possible.
	16mm (0.63") from pallets at pitch of 25mm (0.98"); total 10 pallets possible.
Min. Component dimension:	6mm x 6mm (0.24" x 0.24") mold size
Max. Component dimension:	32mm x 32mm (1.3" x 1.3")
STANDARD COMPONENT CAPACITY	
Max. number of component types:	20 (20 x 1 Jedec tray)
Number of pallets:	Standard 2 x 20 pallets included (additional pallets available PA 2981/36)

Table 18

8.7 Mountable Components & Required Nozzles GEM Topaz-X(i) II

Just five nozzle shapes are required to cover the specified SMD range. High output levels are therefore achieved, as the need for nozzle exchanges is minimal. An optional 18 position nozzle exchange station enables additional special nozzles to be accommodated.

Components		Dimension (mm)			Required nozzle type	
		L	W	T	FNC	SF
	Solid resistor	0.60	0.30	0.25	71F	71
		1.00	0.50	0.50	71F	71
		1.60	0.80	0.50	72F	72
		2.00	1.25	0.50	72F	72
		3.20	1.60	0.60	72F	72
	Solid resistor	2.00	ø 1.25		72F	72
		3.45	ø 1.35		72F	72
		5.9	ø 2.2		72F	72
	Multi-Layered ceramic capacitor	0.6	0.3	0.3	71F	71
		1.0	0.5	0.5	71F	71
		1.50	0.80	0.80	72F	72
		2.00	1.25	1.25	72F	72
		3.20	1.60	1.25	72F	72
		3.20~4.50	2.50~3.20	1.50~1.90	73F	73
		5.60	5.00	1.90	73F	73
	MELF ceramic capacitor	3.40	ø 1.50		73F	73
		5.9	ø 2.2		76A	
	Tantalium electrolytic capacitor	2.90	1.60	1.60	72F	72
		3.80	2.90	1.60	73F	73
		4.70	2.60	2.10	73F	73
		6.00	3.20	2.50	73F	73
		7.30	4.30	2.80	73F	73
	Aluminium electrolytic capacitor	4.3	4.3	5.7	73F	73
		6.6	6.6	5.7	73F	73
		10	10	10.5	74A	

Components		Dimension (mm)			Required nozzle type	
		L	W	T	FNC	SF
	Chip film capacitor	7.3	5.3	3.25	73F	73
	Chip inductor	3.2	2.5	2.0	73F	73
		4.5	3.2	3.2	73F	73
	Semi-variable resistor	4.5	3.8	2.4	73F	73
	Transistor (SOT)	2.90	1.5	1.10	72F	72
		4.0	3	1.8	73F	73
	Power transistor	4.6	2.6	1.6	73F	73
	SOP (6 ~ 28 pin)	5.00	4.50	1.50	73F	73
		7.60	4.50	1.50	73F	73
		10.10	4.50	1.50	73F	73
		12.60	5.70	1.50	73F	73
		15.30	7.50	2.00	74A	
		17.80	7.50	2.00	74A	
	PLCC	⌀ 5~16			73F	73
		⌀ 15~20			74A	
		⌀ 15~32			74A	
	QFP	⌀ 5~16			74A	
		⌀ 15~20			74A	
		⌀ 15~32			74A	
	BGA	⌀ 10~26			74A	
		⌀ 10~30			74A	

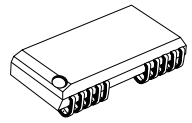
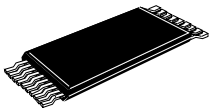
Components		Dimension (mm)			Required nozzle type	
		L	W	T	FNC	SF
	SOJ (20 ~ 42 pin)	⍁ 10~20			73F	73
		⍁ 15~30			74A	
	TSOP (20 ~ 32 pin)	⍁ 10~20			73F	73
		⍁ 15~30			74A	

Table 19

For information on CSP, µBGA, bare chip and other types of components, please consult your local sales representative.

9.0 Topaz-X(i) II Summary

	Model	Topaz-X II (FNC)	Topaz-X II (SF)	Topaz-Xi II (FNC)	Topaz-Xi II (SF)
	PA number	**PA 1314/01**	**PA 1314/02**	**PA 1314/10**	**PA 1314/11**
Head	Flying Nozzle Change head (FNC)	•		•	
	Super Fine head (SF)		•		•
	Nozzle Exchange station	o	o	o	o
	Special order nozzles	*	*	*	*
Recognition system	Line Array camera	•	•	•	•
	Second line Array camera	o	o	o	o
	Area CCD camera 32mm including illumination unit	o	o	o	o
	Fiducial camera	•	•	•	•
Feeding	Pneumatic Tape Feeder	•	•		
	Intelligent Tape Feeder			•	•
	Bulk Feeder	o	o		
	Stick Feeder	o	o	o	o
	Double Shuttle Tray Feeder (LCS)	o	o	o	o
	Reject station	o	o	o	o
	ATS 20 Tray Feeder portrait	o	o	o	o
	Double ATS 20 Tray Feeder portrait	o	o	o	o
	ATS 20 Tray Feeder landscape	o	o		
	Manual Tray Feeder	o	o		
	Feeder Exchange System (FES 20)	o	o		
PCB positioning/transport	Main Stopper	•	•	•	•
	Locate Pin	•	•	•	•
	Edge Clamp System	•	•	•	•
	Board Clamp System	o	o	o	o
	Z servo controlled Push Up Plate	•	•	•	•
	Entrance Sub Stopper	•	•	•	•
	Exit Sub Stopper	•	•	•	•
	Automatic Width Adjustment	•	•	•	•
	High Speed soft-stop conveyor	•	•	•	•
	Reverse transfer Right to Left	o	o	o	o
	Ceramic PCBs	o	o	o	o
	Special sized PCBs	*	*	*	*
Safety	Feeder Floating Detection	•	•	•	•
	Conveyor Entrance/Exit covers	•	•	•	•
	Safety cover for feeder exchange	•	•	•	•
	Dummy Feeders	•	•	•	•
	Safety specifications according CE standards	•	•	•	•
	Spare parts kit + tools	•	•	•	•
	SMEMA kit	•	•	•	•
	Front and rear anti-static covers	•	•	•	•
	Signal tower + warning buzzer	•	•	•	•
Software	Windows NT Graphical User Interface	•	•	•	•
	Multiple Accuracy Compensation System	•	•	•	•
	Bad Mark / Master Mark Sensing	•	•	•	•
	Fiducial recovery function	•	•	•	•
	On-line teaching	•	•	•	•
	Alternative Feeder Function	•	•	•	•
	Automatic program change	•	•	•	•
	Variable XY axis speed per component	•	•	•	•
	On-line Help function	•	•	•	•
	Management Information System	•	•	•	•
	Template (pattern matching)	•	•	•	•
	Automatic rework cycle	•	•	•	•
	On-line data generator	•	•	•	•

Table 19

• = *Standard*
o = *Optional*
* = *Special order*

Assembléon

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